

TWENTY-FOURTH ANNUAL



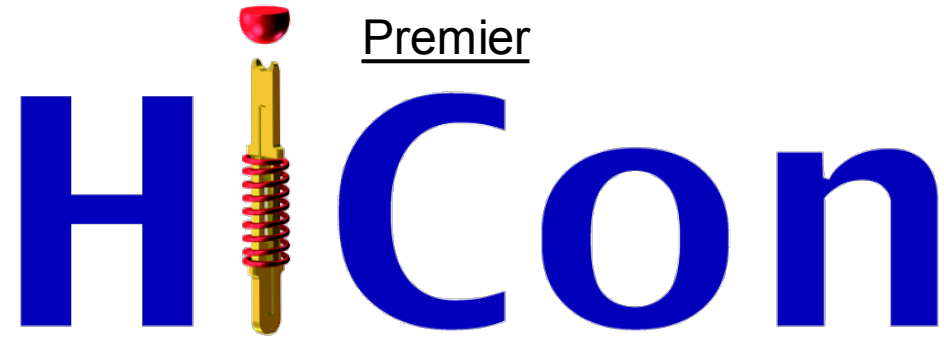
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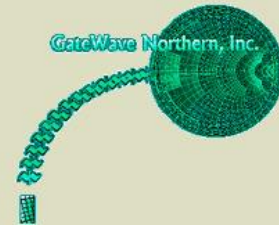
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mm Waves vs. Test Sockets

Gert Hohenwarter
GateWave Northern, Inc.



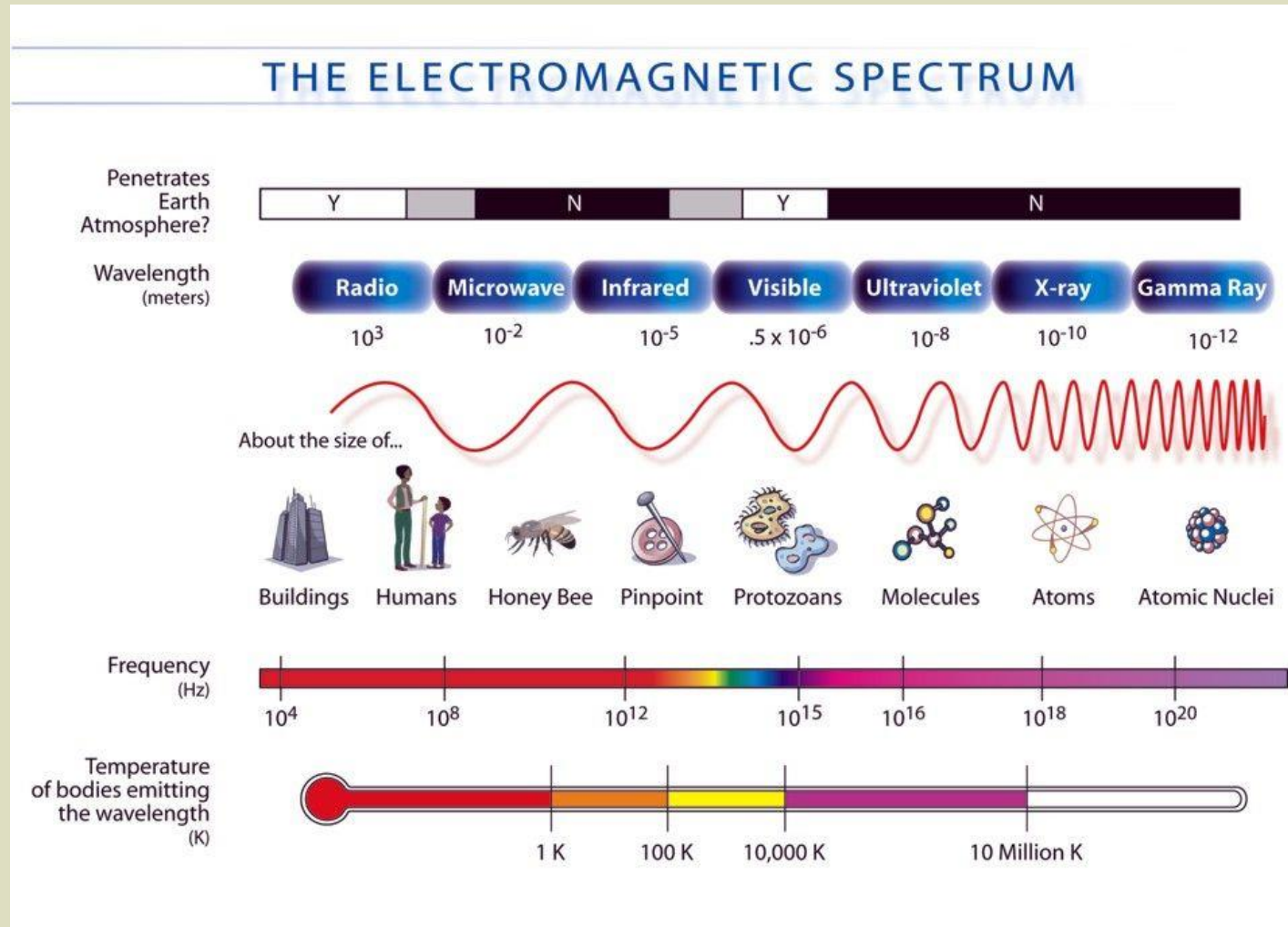
Outline

- Introduction to mm waves
- Material behavior
- Wavelength effects
 - Resonances
 - Transitions
 - Propagation and loss
- Testing

Objective

- A brief look at mm-waves and their unique characteristics is provided first to set the stage
- Material properties for high frequency operation are briefly illuminated
- Once a basic understanding is developed, socket design pitfalls will be addressed
- Why is there a “vs.” in the title ?

Wavelength vs. Frequency Visualized



Source: Luzzilice Luzia Planet Fragile Torus on Pinterest

mm Waves

- What are “mm Waves”?
 - electromagnetic signals with 10 to 1 mm wavelength
 - 30 GHz - 300 GHz
 - Also called EHF (extremely high frequency) or mmW / MMW

- Where are they used ?
 - 5G and short range communications, IoT
 - automotive radar, security scanners
 - Prior to 5G/automotive :
 - Science / radio astronomy / medicine
 - military fire-control radar

mm Waves Strengths

- Large data rates, video
- Instant response (IoT)
- Good resolution (radar)
- Immunity from interference (short range, directivity)
- Spectrum reuse (short range)
- Small antennas, antenna arrays

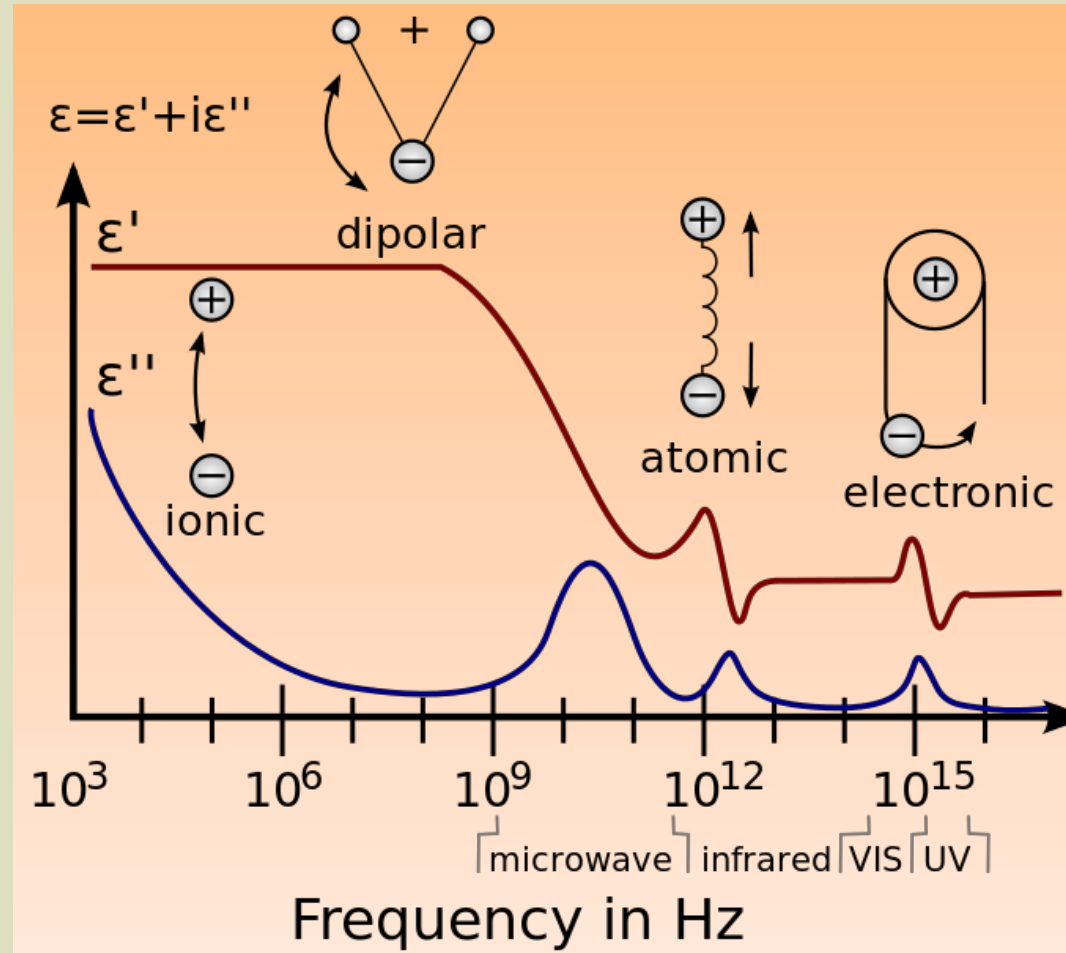
mm Waves Weaknesses

- Short range (gases, rain drops, humidity)
- No propagation around obstacles
- Loss in traditional circuitry e.g. PCBs, interconnects
- Cost

mm Waves – what changes ?

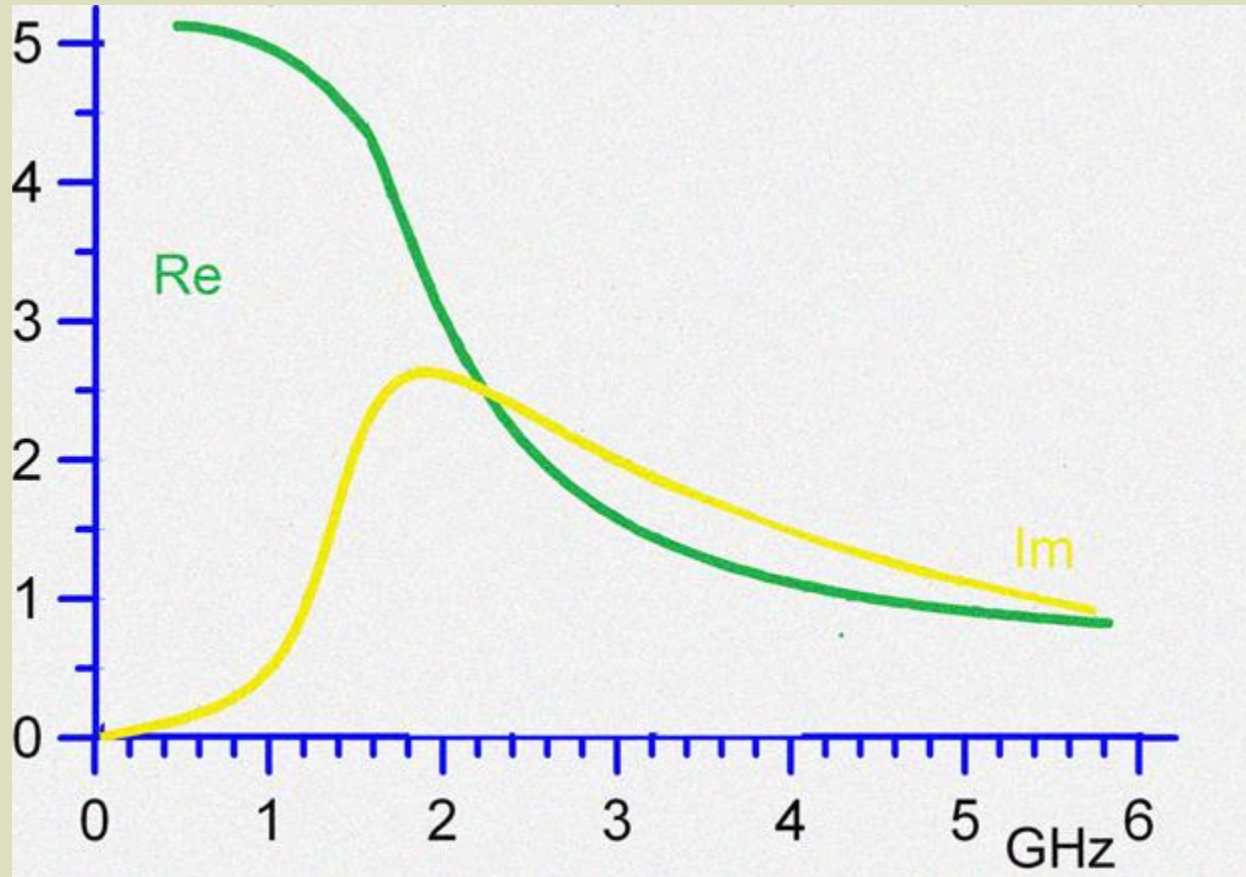
- Lateral dimensions in sockets on the order of significant fractions of wavelength
- Skin depth, roughness, ‘detours’ into contact, multiple spheres
- Radiation into test environment
- Instrumentation accuracy, cost
- Simulation accuracy (component detail, simulation setup, mesh size)
- Material properties often unknown

Permittivity (dielectric constant) and Frequency



Source: Wikimedia File: Dielectric responses.svg

Permeability (response to magnetization) and Frequency



Observation:

Permeability approaches '1' as frequency increases since heavy dipoles cannot respond fast enough to stimulus.

Hence there is no impact to be expected on millimeter wave frequency operation.

Wavelength vs. Frequency

- $\lambda = c / f$ (c = $3 \cdot 10^8$ m/s)

(in free space ~air)

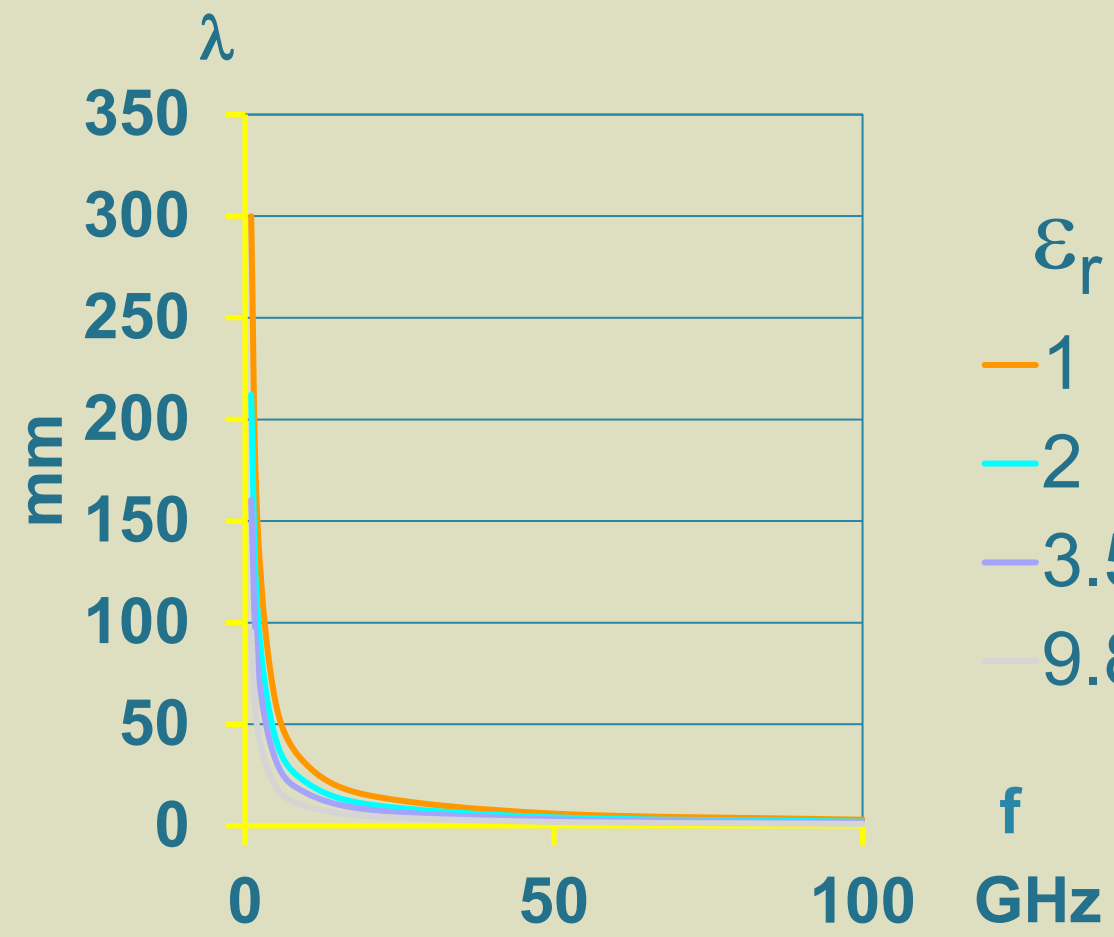
- $c = 1 / \sqrt{\mu * \epsilon}$

(in matter)

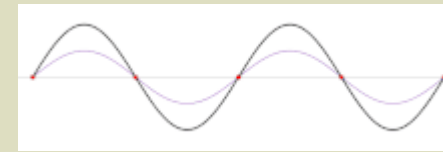
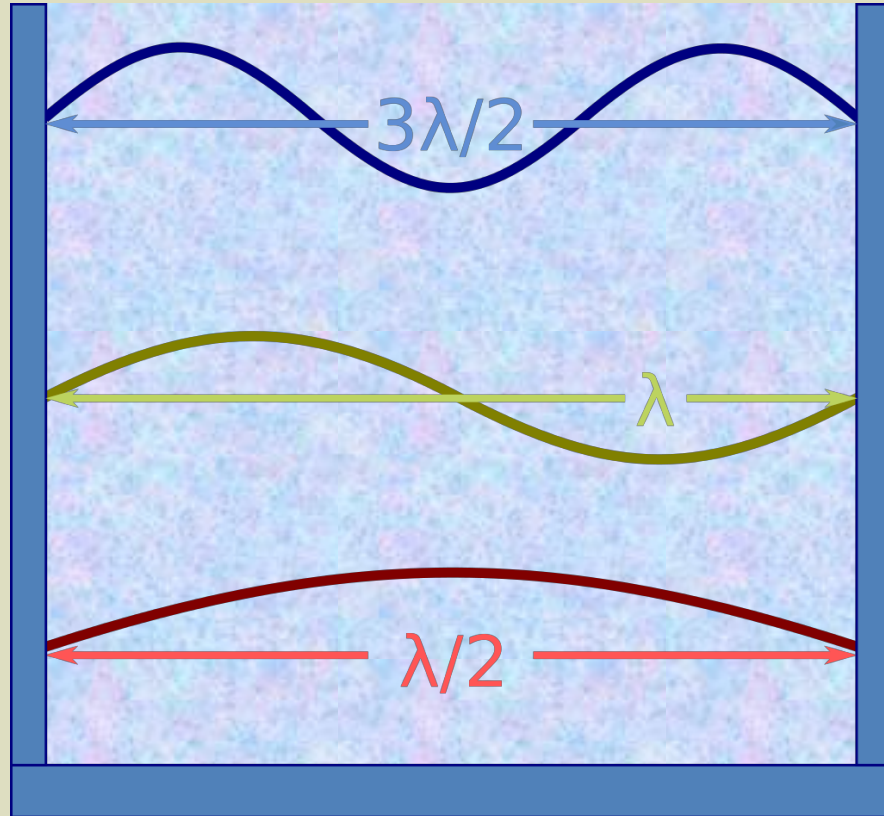
$\epsilon =$ *permittivity*

$\mu =$ *permeability*

Wavelength vs. Frequency vs. Dielectric Constant



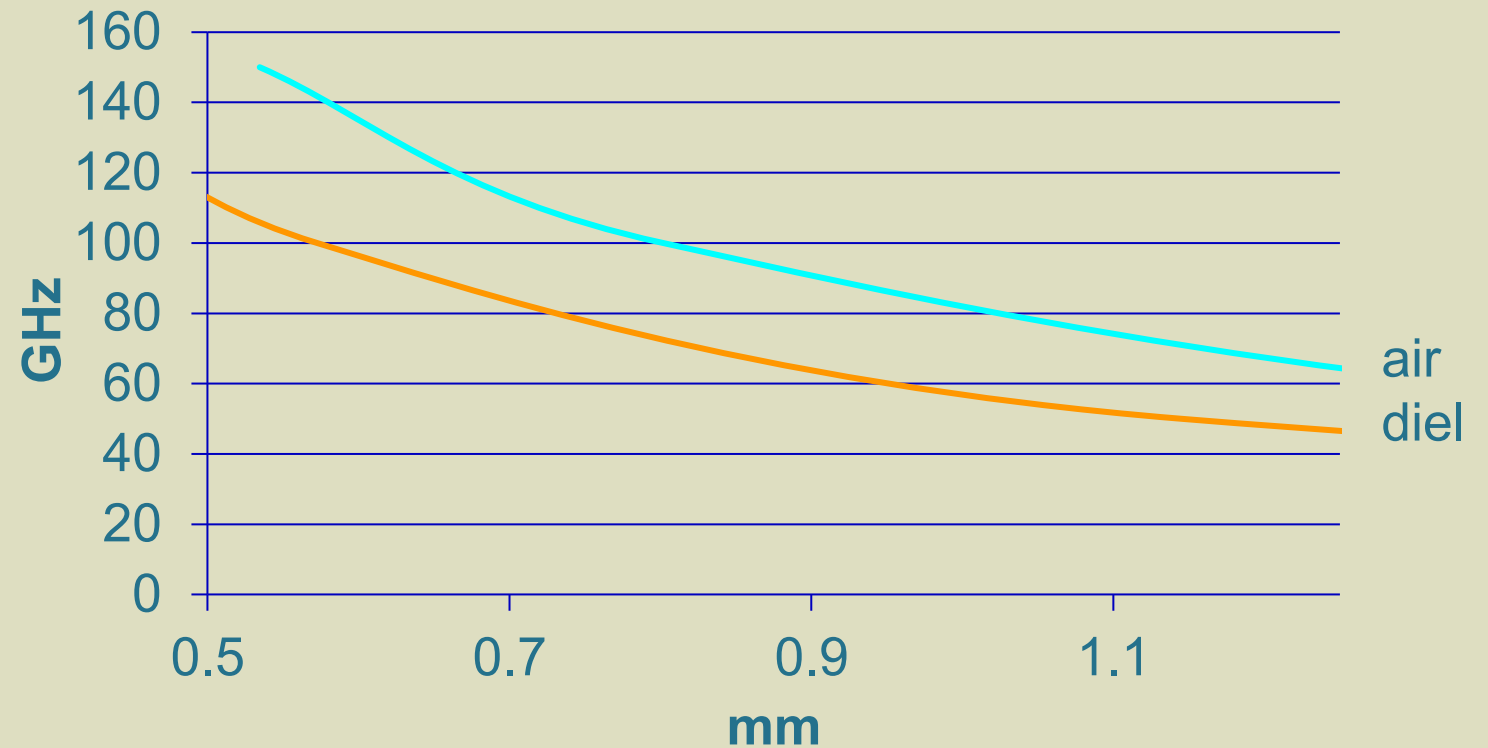
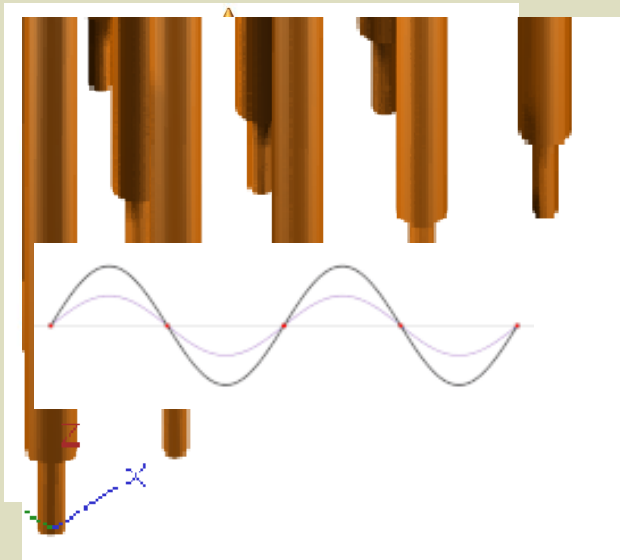
Waves in a Box



Source: <https://commons.wikimedia.org/w/index.php?curid=7115416>
Badseed working on a raster by Brews_ohare - Own work

Wavelength vs. Frequency Visualized

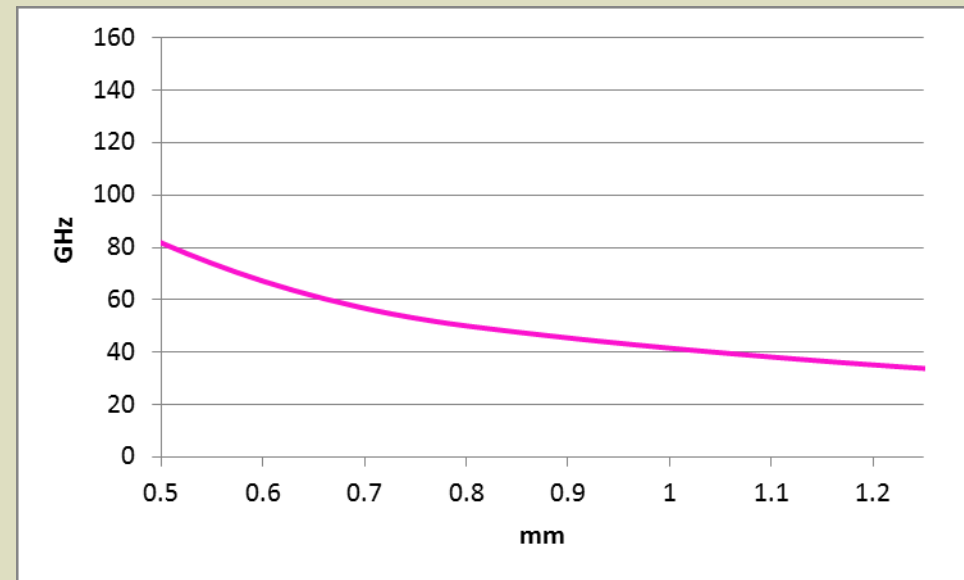
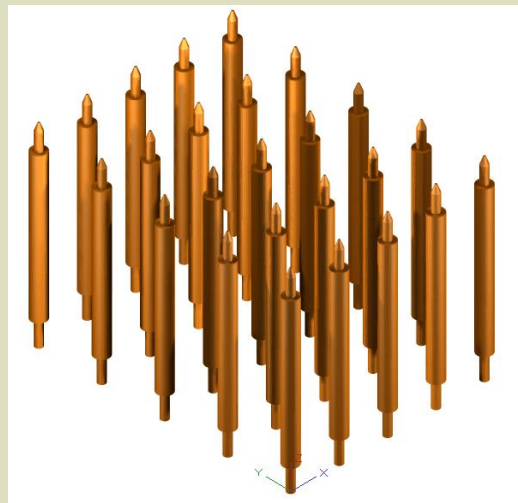
mm waves – mm pitch



Resonances in the transverse direction (so-called modes) occur at elevated frequencies

Wavelength vs. Frequency Visualized

Length vs.
wavelength



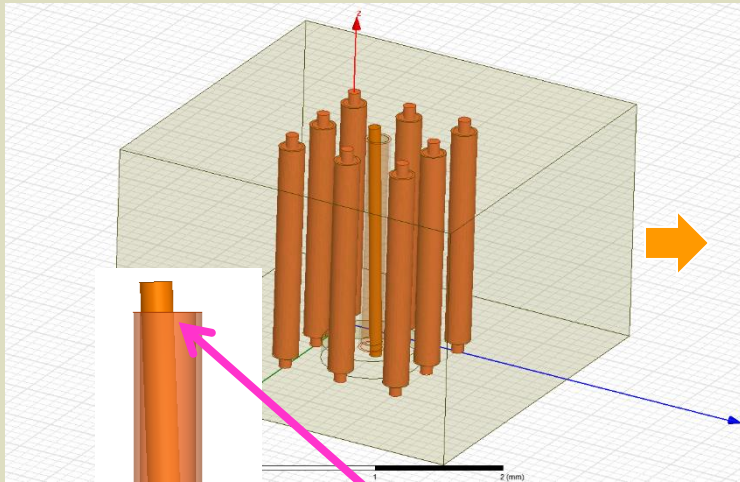
Resonances in the longitudinal direction (so-called modes) occur at elevated frequencies

So what are the consequences of using short wavelengths in a test socket environment ?

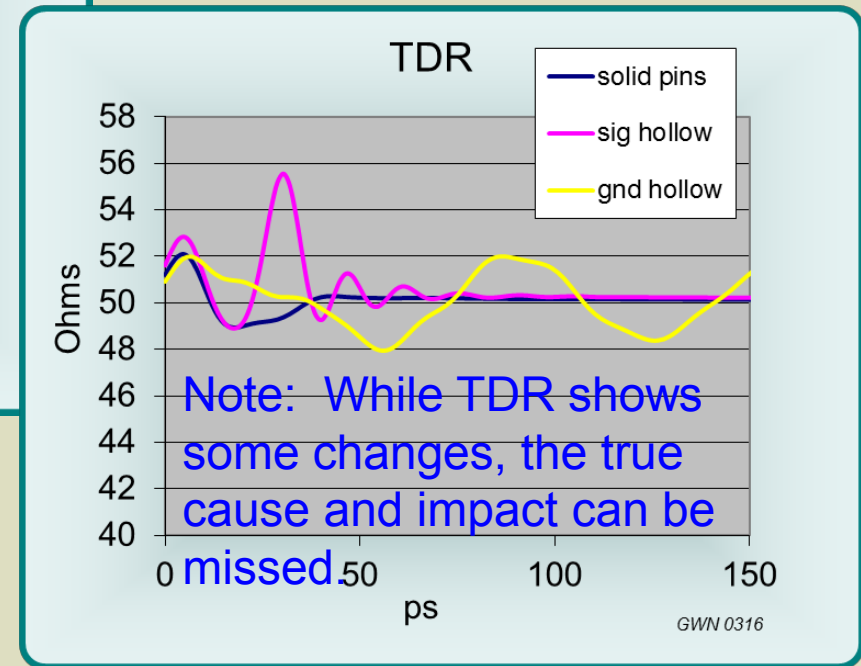
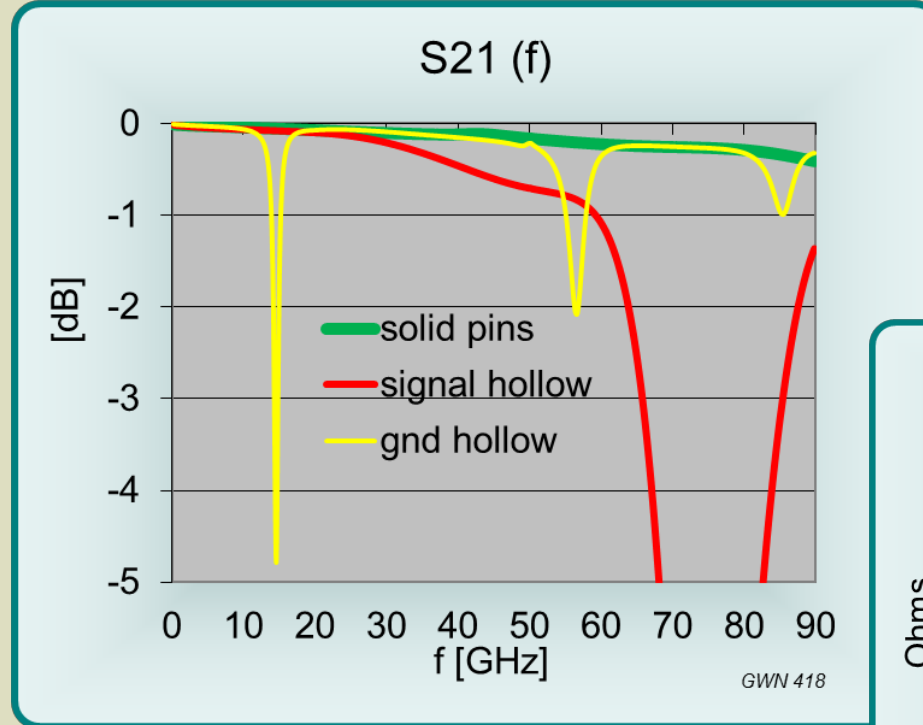
Resonances !

- Smooth transitions needed
- More loss

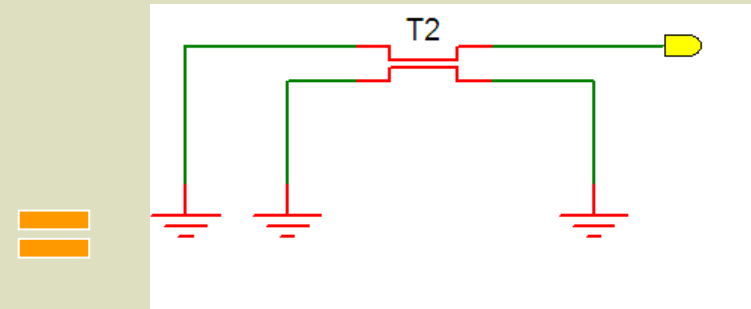
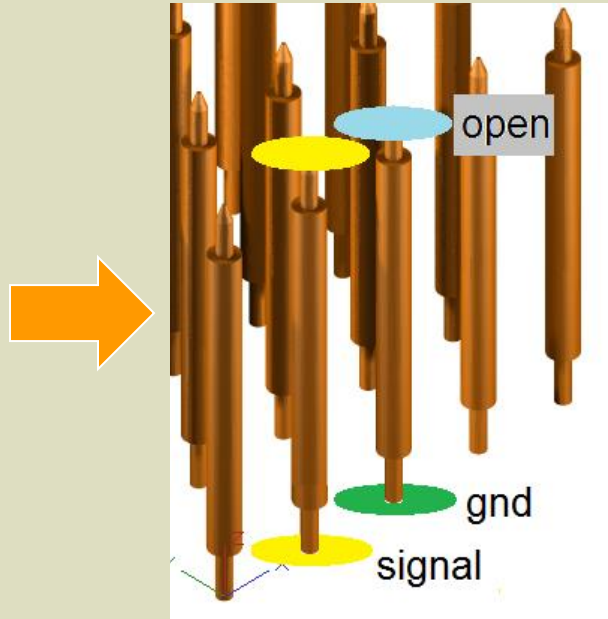
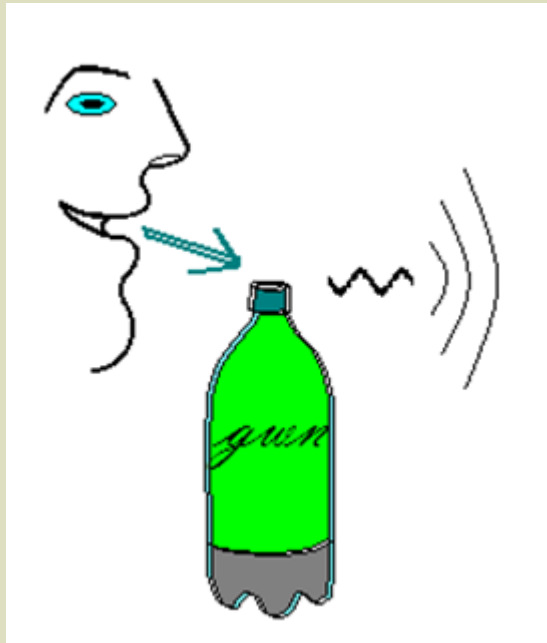
Internal Pin Resonance Effects



Plunger touches only at top and bottom, leading to resonances inside pins at elevated frequencies.



Adjacent Pin Resonance Effects

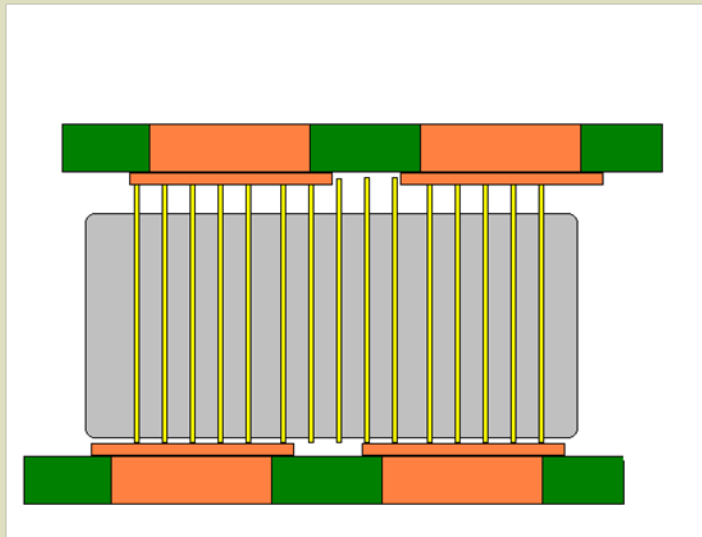
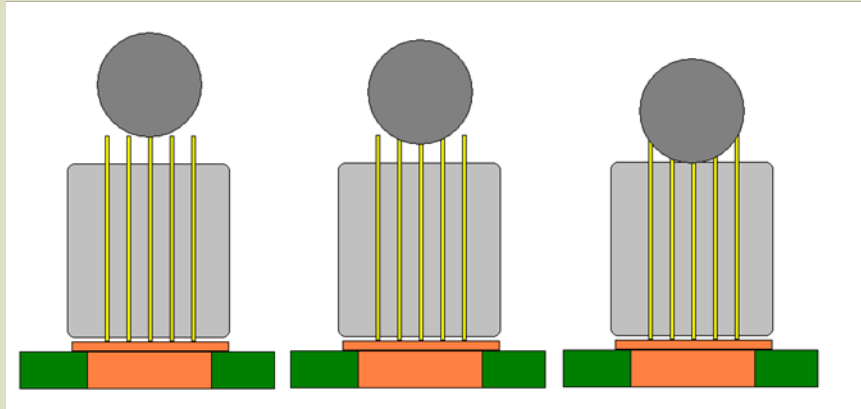


$$f_{\text{res}} = \lambda / 4$$

100 GHz \sim 2mm/4 \sim 0.5mm in polyimide

Resonances in ungrounded or partially grounded pins can occur at elevated frequencies

Inadvertent Adjacent Pin Resonances

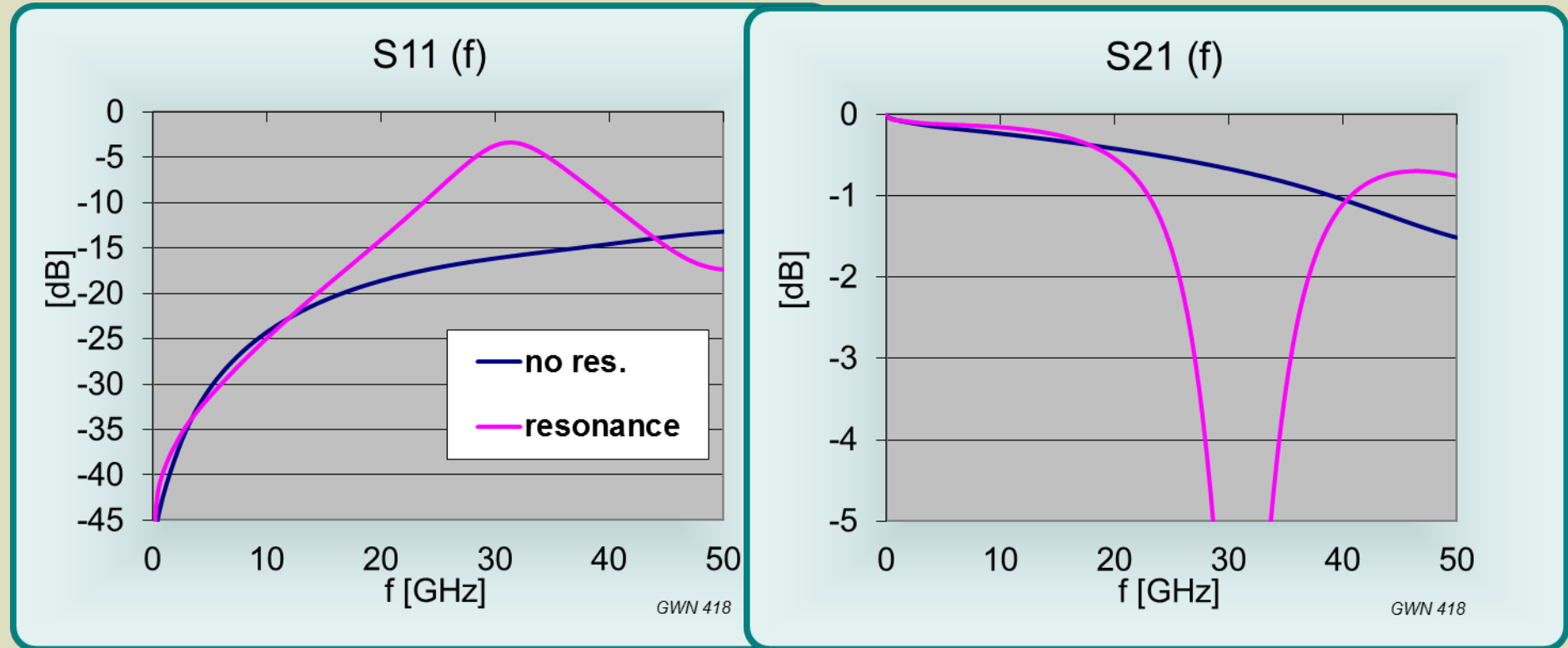
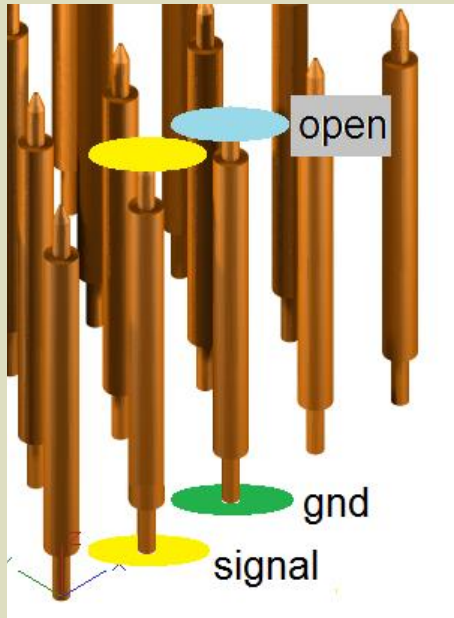


If not properly configured parallel conductors can contribute to resonances



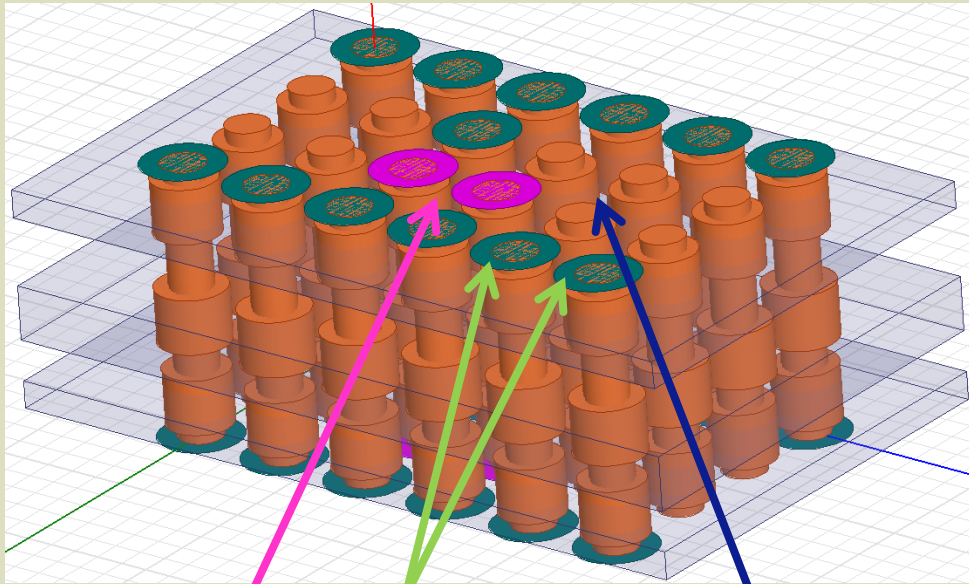
Insertion loss measured for 3 different displacements

Adjacent Pin Resonance Effects



Resonances in ungrounded or partially grounded pins can occur at elevated frequencies

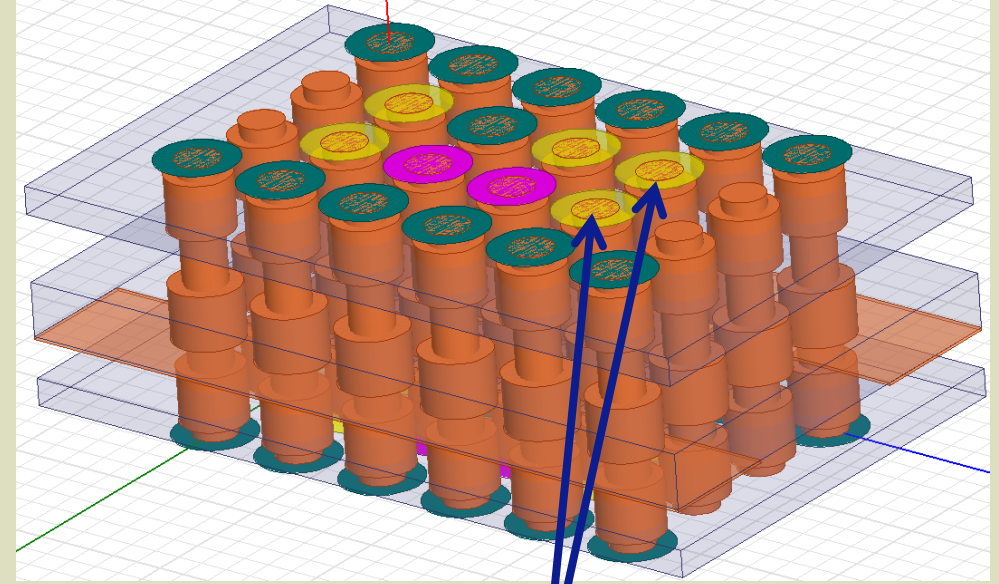
External Pin Resonance Effects



Ground (all green)

Differential signals

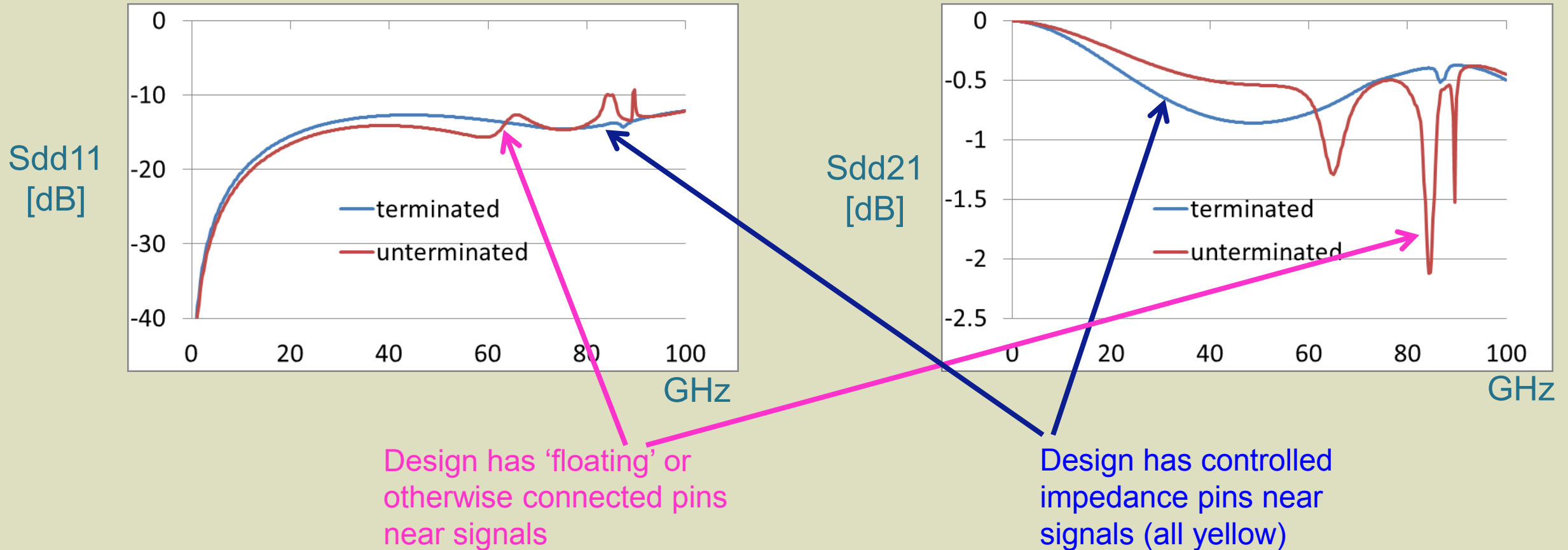
Design has 'floating' or otherwise not matched impedance pins near signals



Design has controlled impedance pins near signals (all yellow)

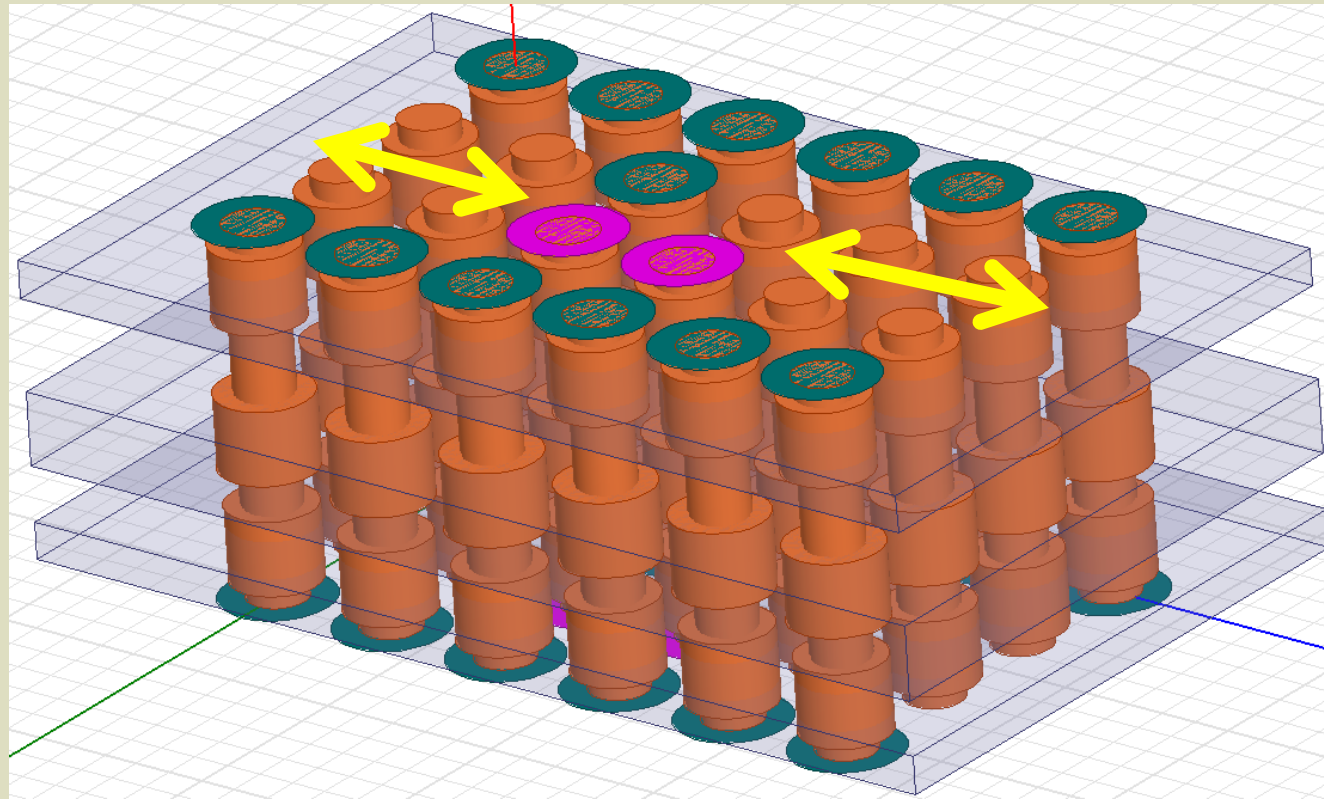
Thickness = 1mm
Pitch = 0.35mm

External Pin Resonance Effects



In general: Resonances appear when wavelength drops below twice pin length, but length here is only 1mm !!

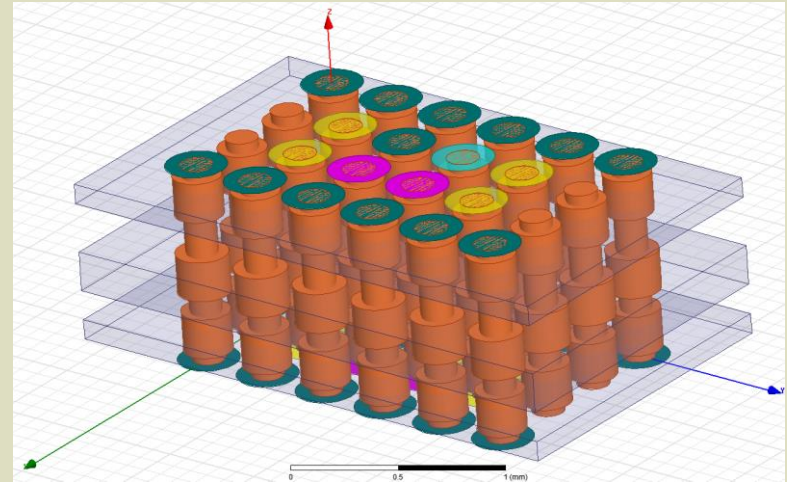
External Pin Resonance Effects



Resonances in this case occur orthogonal to arrangement as indicated and depend on pin configuration and socket boundaries

Partially terminated pins

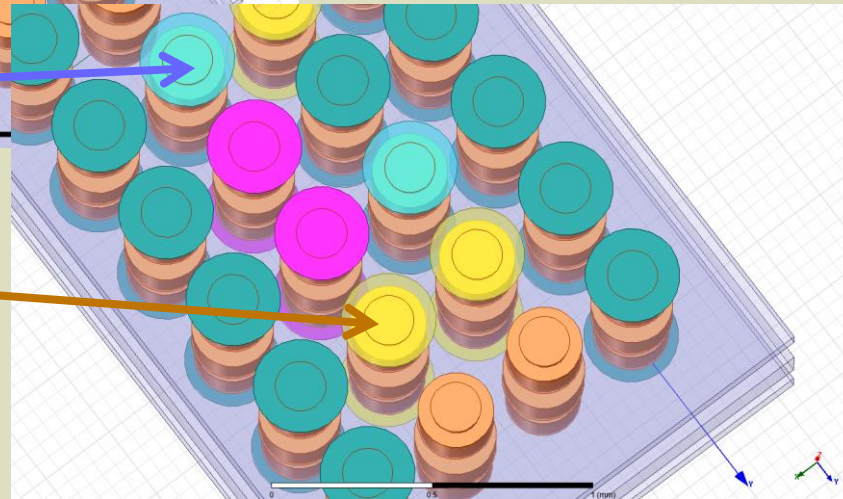
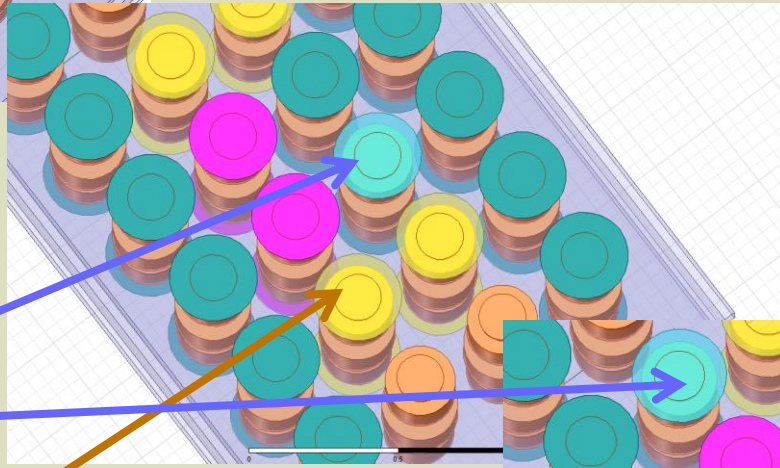
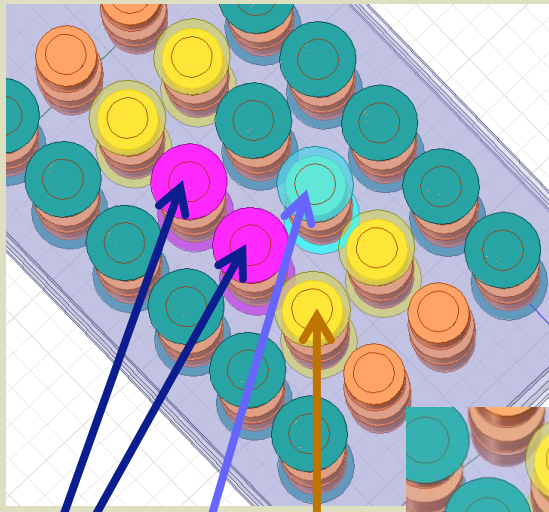
Thickness = 1mm
Pitch = 0.35mm



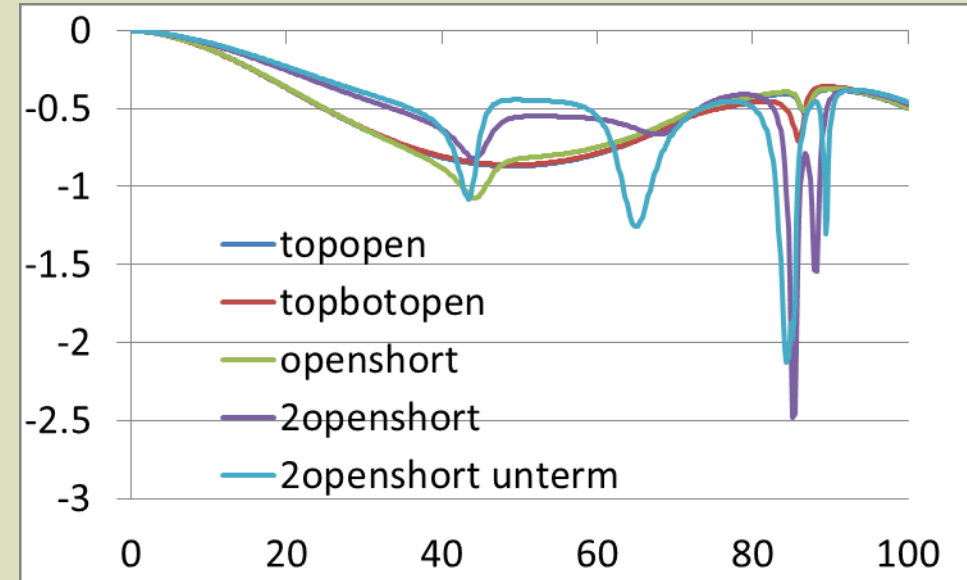
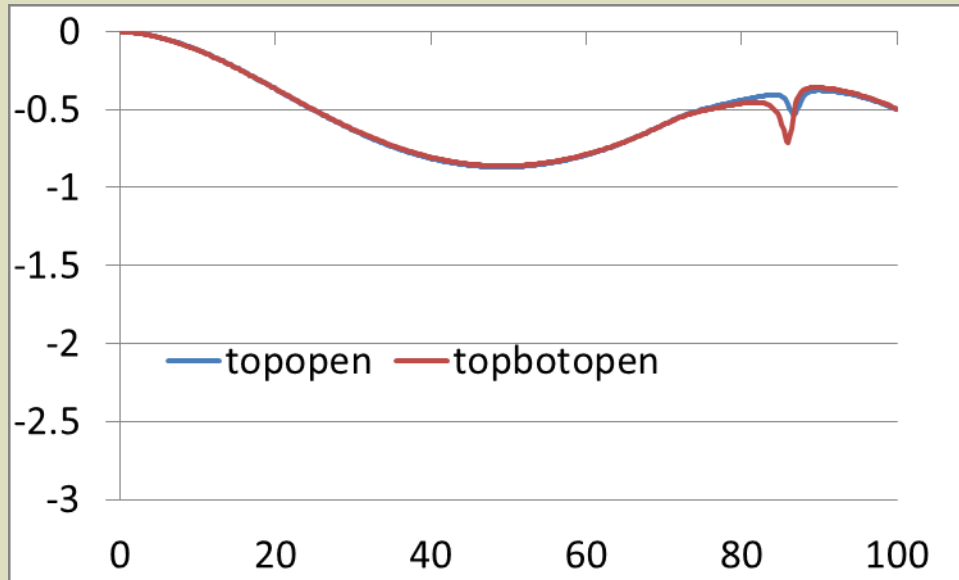
Diff signals (pink)

Open contact (blue)

Terminated contacts (yellow)

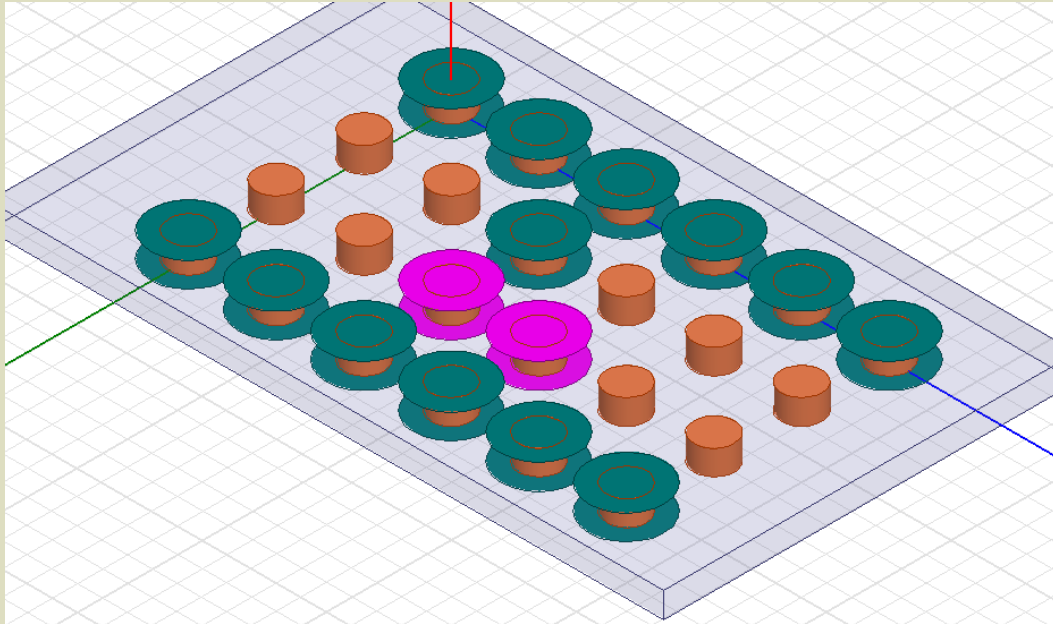


Partially terminated pins



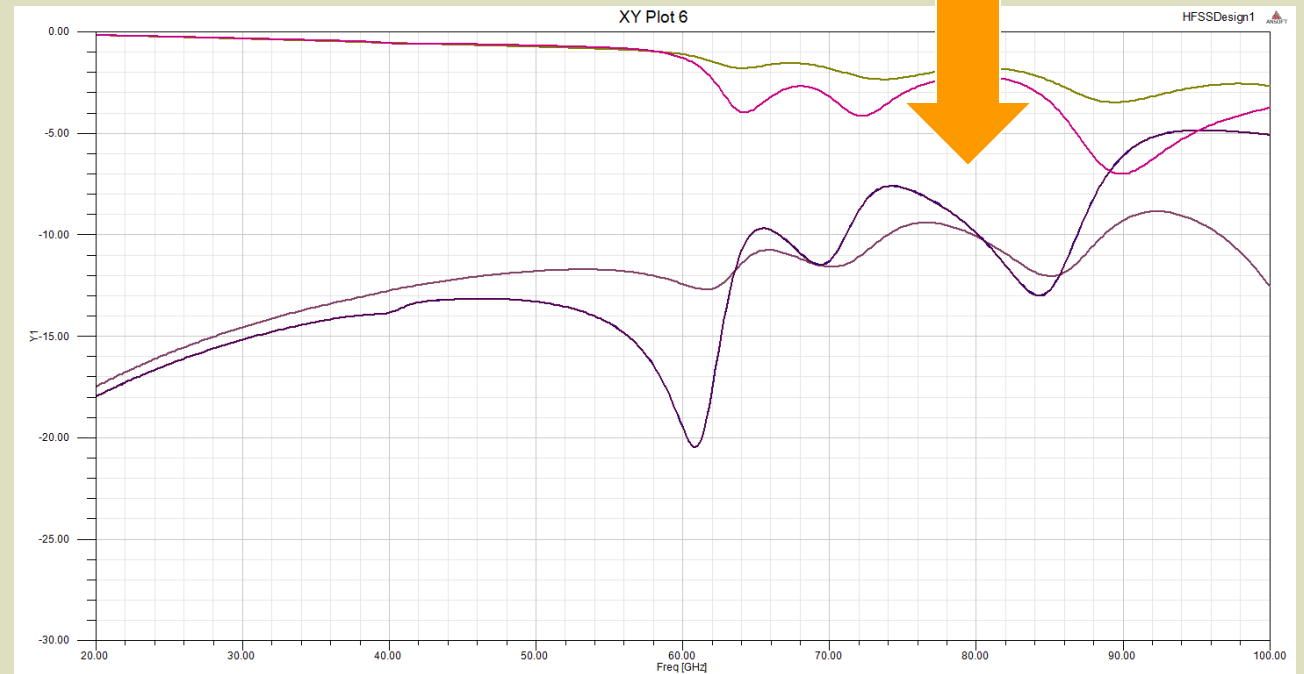
While a single open circuited contact may be ok (left), insertion loss (S21) shows problems in the presence of only a few improperly terminated contacts

Ultra-thin interface



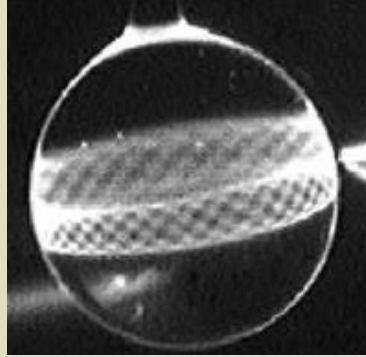
0.1 mm thick
0.65 mm pitch

“It” can (and will) still happen, just at higher frequencies



Other resonance effects

- Dielectric resonator
- Whispering gallery modes

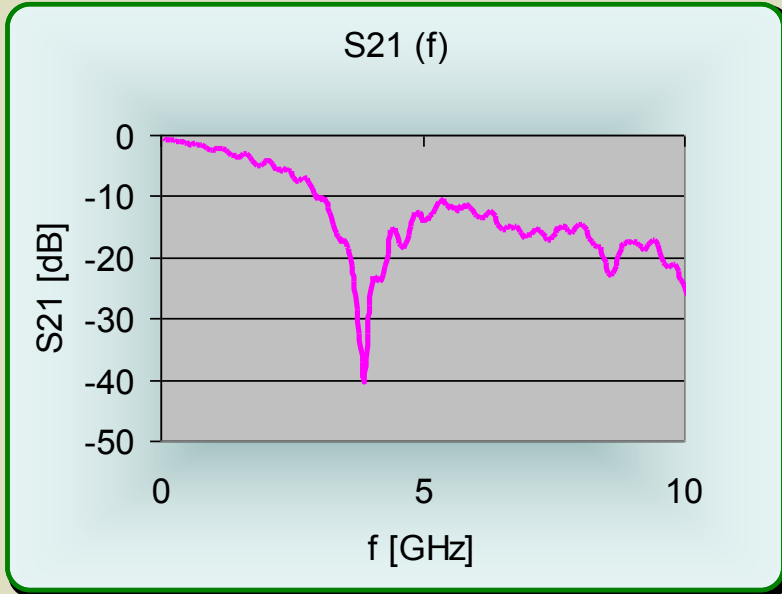


Source: Wikimedia - File:Whispering gallery modes sphere.png

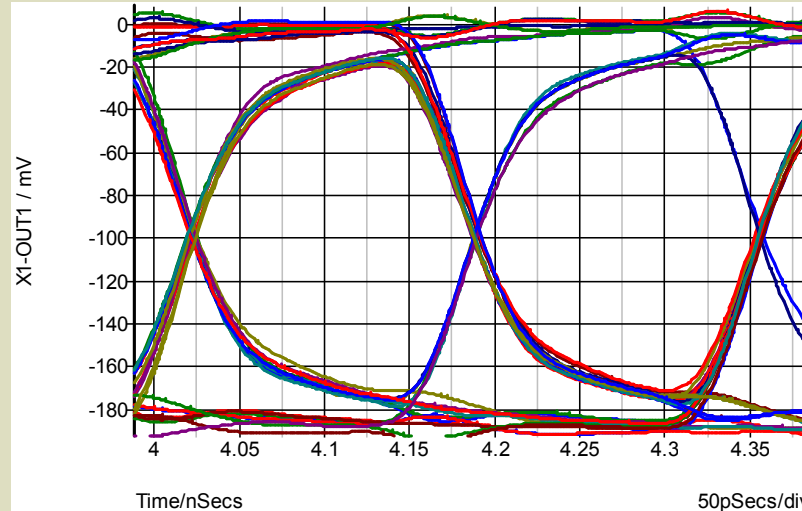


Source: Wikimedia - File:St Paul's Cathedral Whispering Gallery.jpg

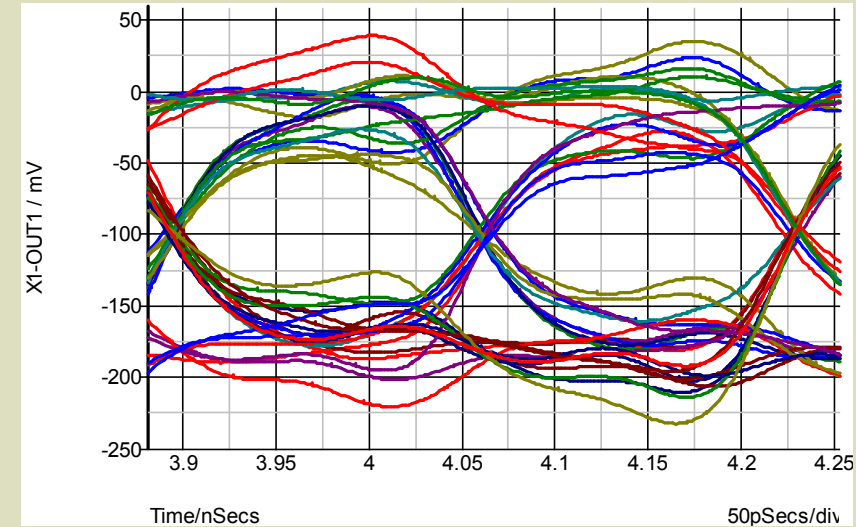
Eye Diagram in the Presence of Resonances



Measured insertion loss S21 of a load board with a parasitic resonance



no resonance



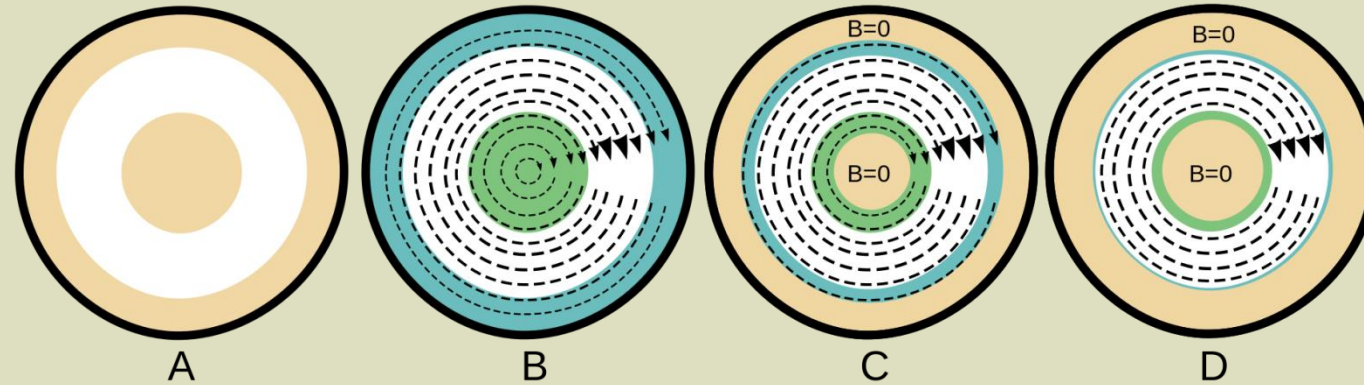
resonance

Noticeable degradation of load board eye diagram (6Gbps) from a 3 GHz resonance

Wave propagation at mm waves

What other considerations must be applied for sending mm-wave signals through PCBs and sockets?

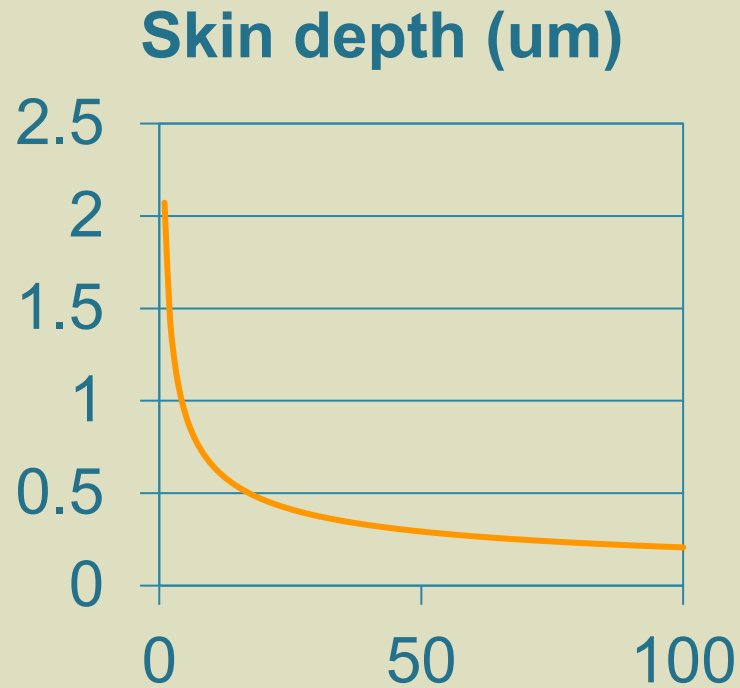
RF current flow



With progressively increasing frequency the RF current penetrates the conductors less and less

Source: Wikimedia - File:Coax and Skin depth.png, CC0,
<https://commons.wikimedia.org/w/index.php?curid=14208109>

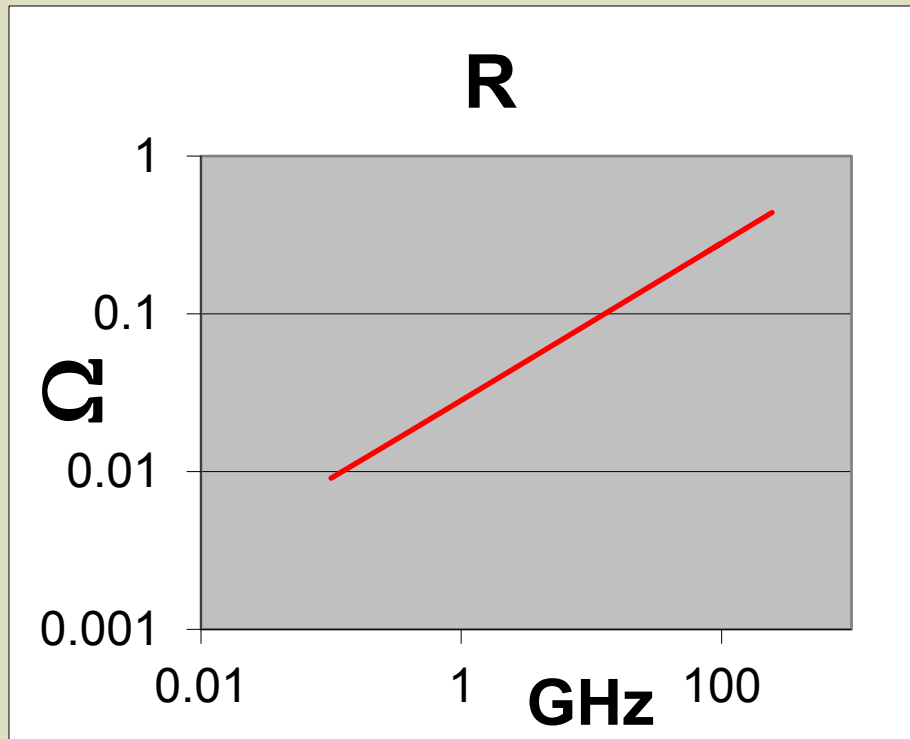
Skin depth



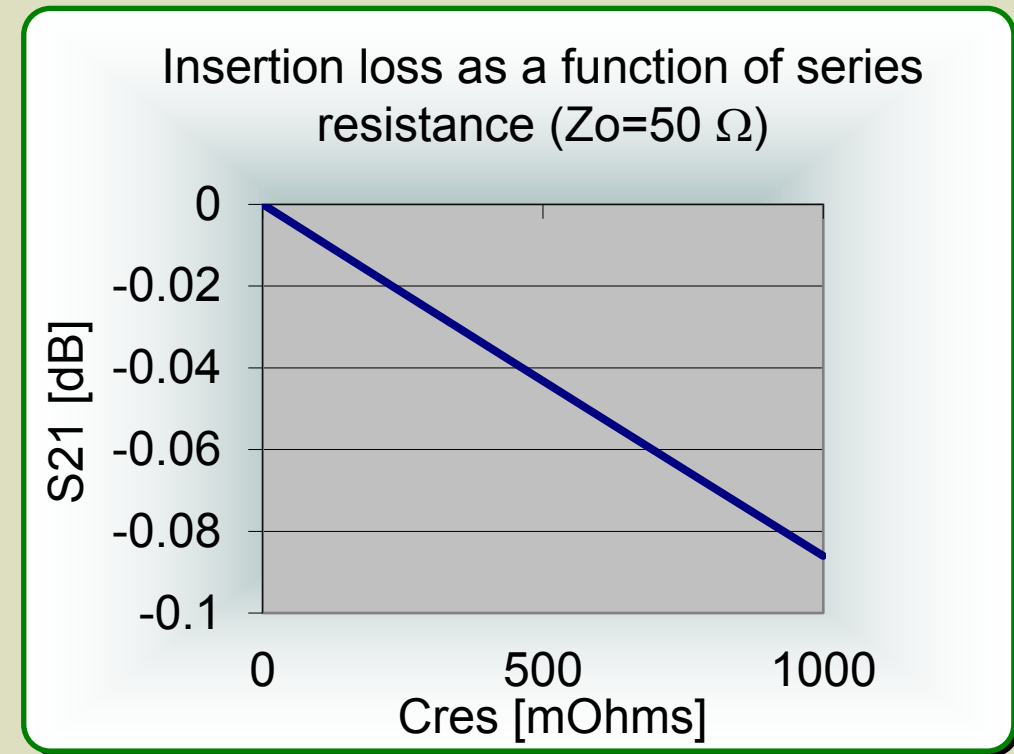
$$\delta = \sqrt{\frac{2\rho}{\omega\mu}}$$

$$R = \frac{\rho}{\delta} \left(\frac{L}{\pi(D - \delta)} \right) \approx \frac{\rho}{\delta} \left(\frac{L}{\pi D} \right)$$

Effective Resistance as a Function of Frequency



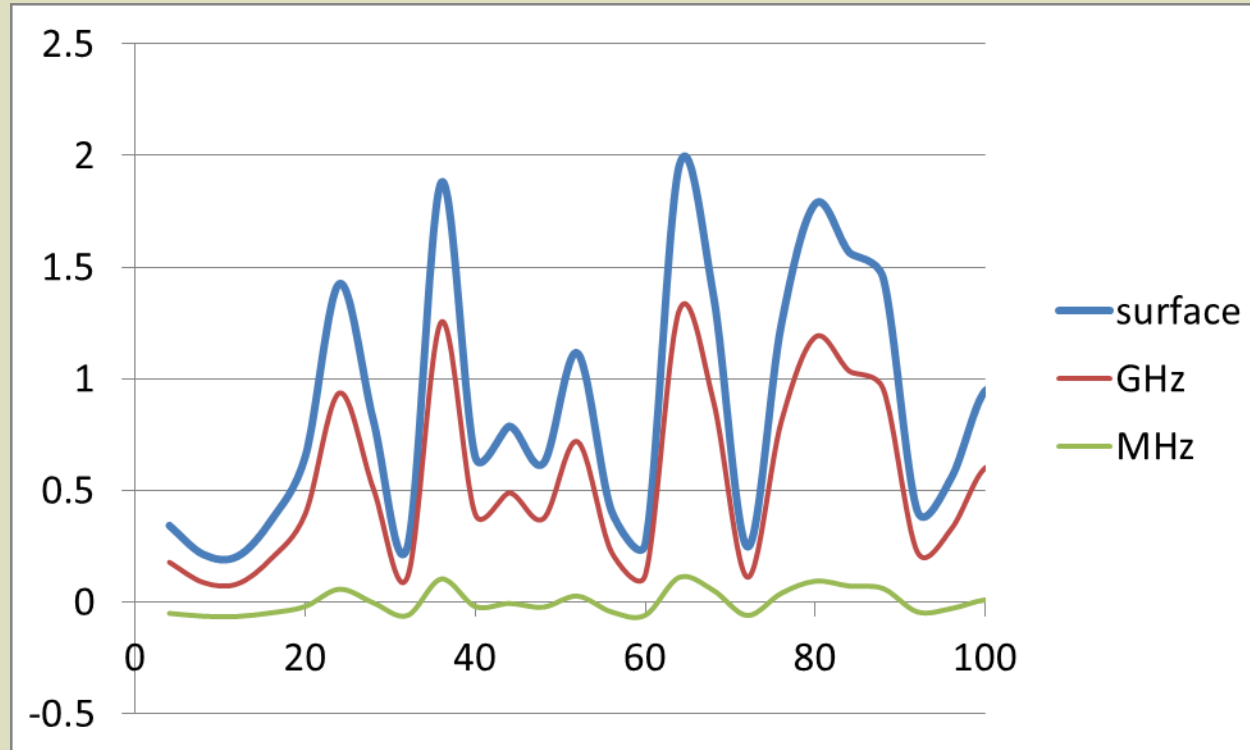
This illustrates the drastic change of effective resistance due to the skin effect (single piece contact, 3mm long).



However, for short contacts this is of little consequence (example is for a typical one piece contact).

Surface Roughness Illustration

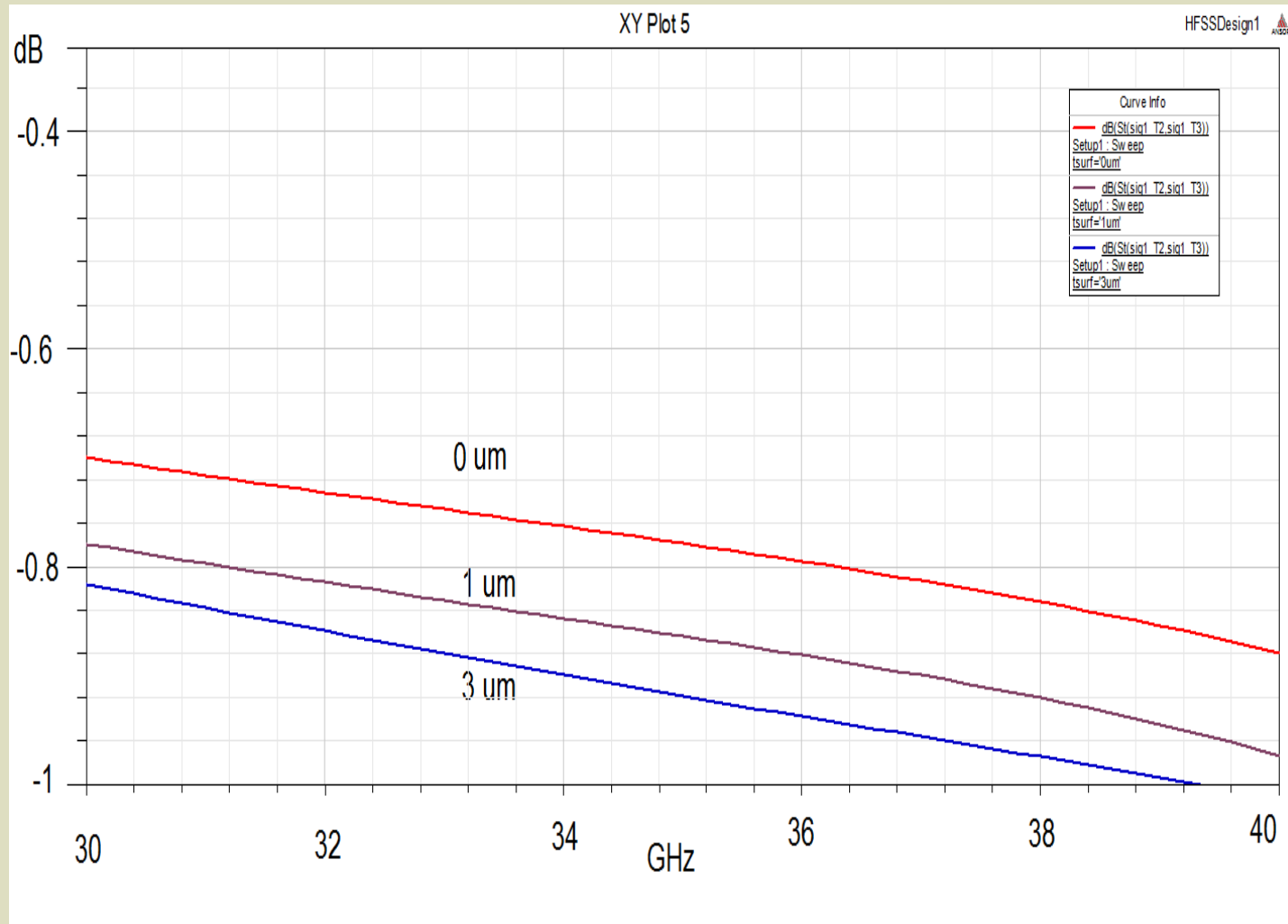
δ [μm]



x [μm]

Illustration of approximate paths for different frequency RF signals
additional path length here is only approximately 2% for small skin depth

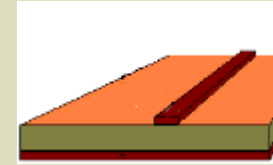
Coax Loss vs. Surface Roughness



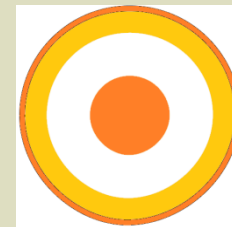
Loss of a 100 mm long coax as a function of surface roughness

Moving mm waves

- PCB transmission lines (short)



- Coax (semi-rigid preferred)

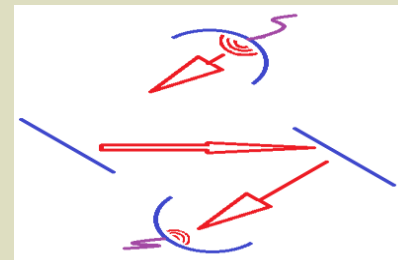


- Waveguide



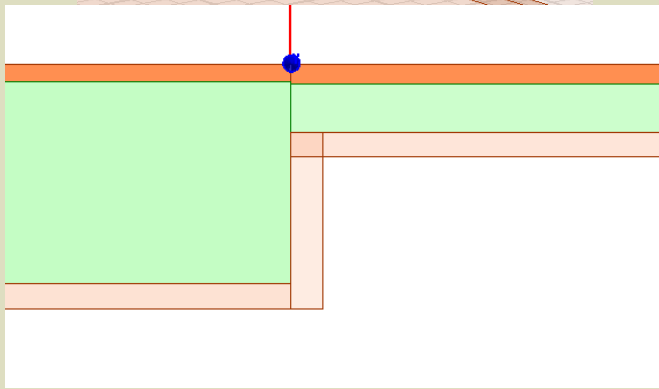
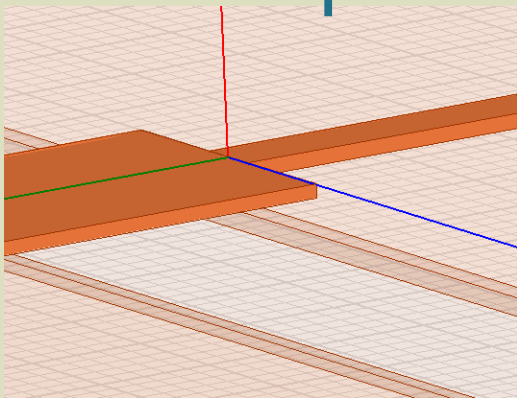
Source: Wikimedia
File:Sound-waveguide-drain.jpg

- Beam waveguide

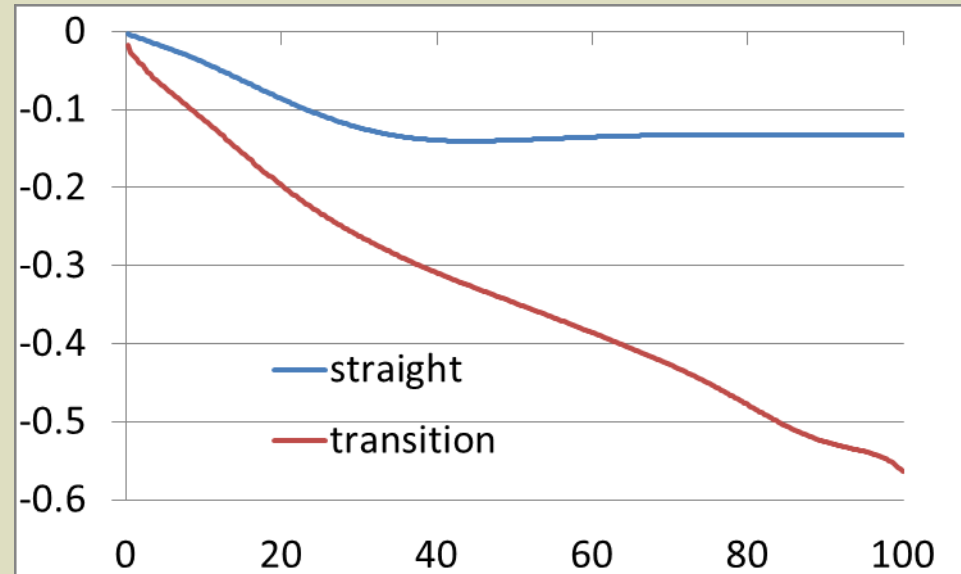


Moving mm waves across boundaries

Transition smoothness becomes important:

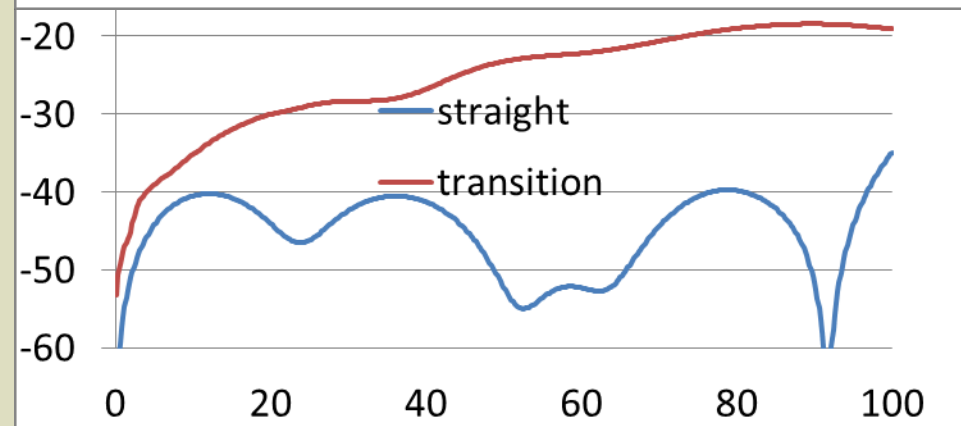


S21



dB

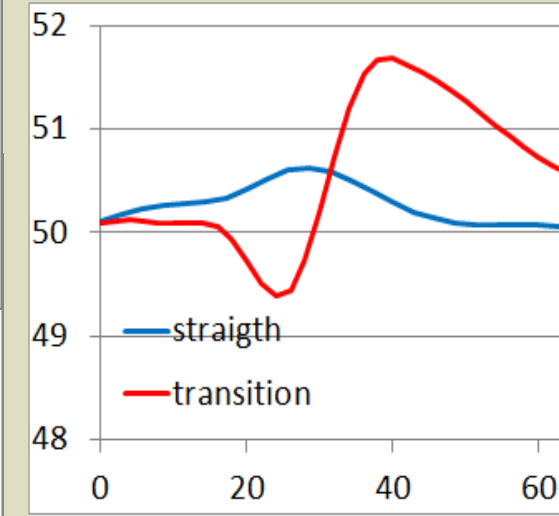
S11



GHz

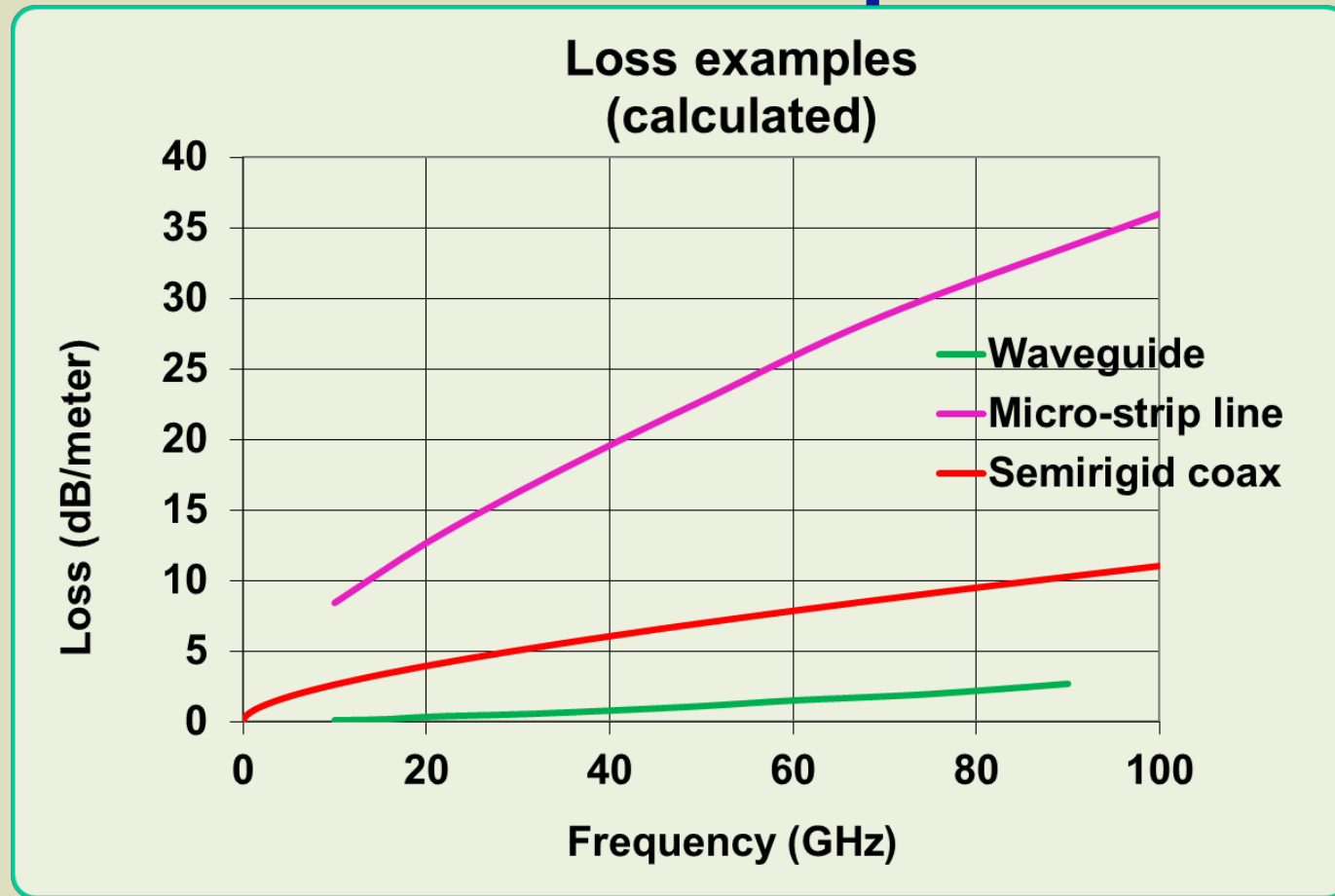
TDR

Ohm



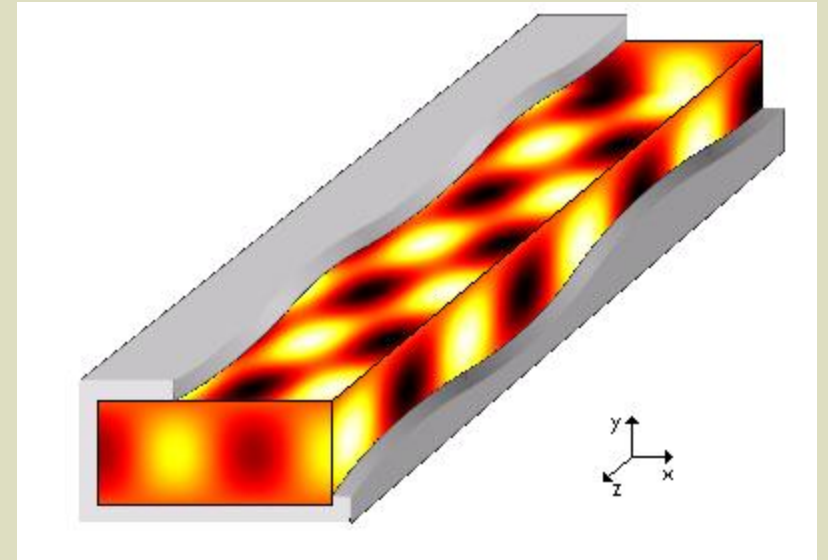
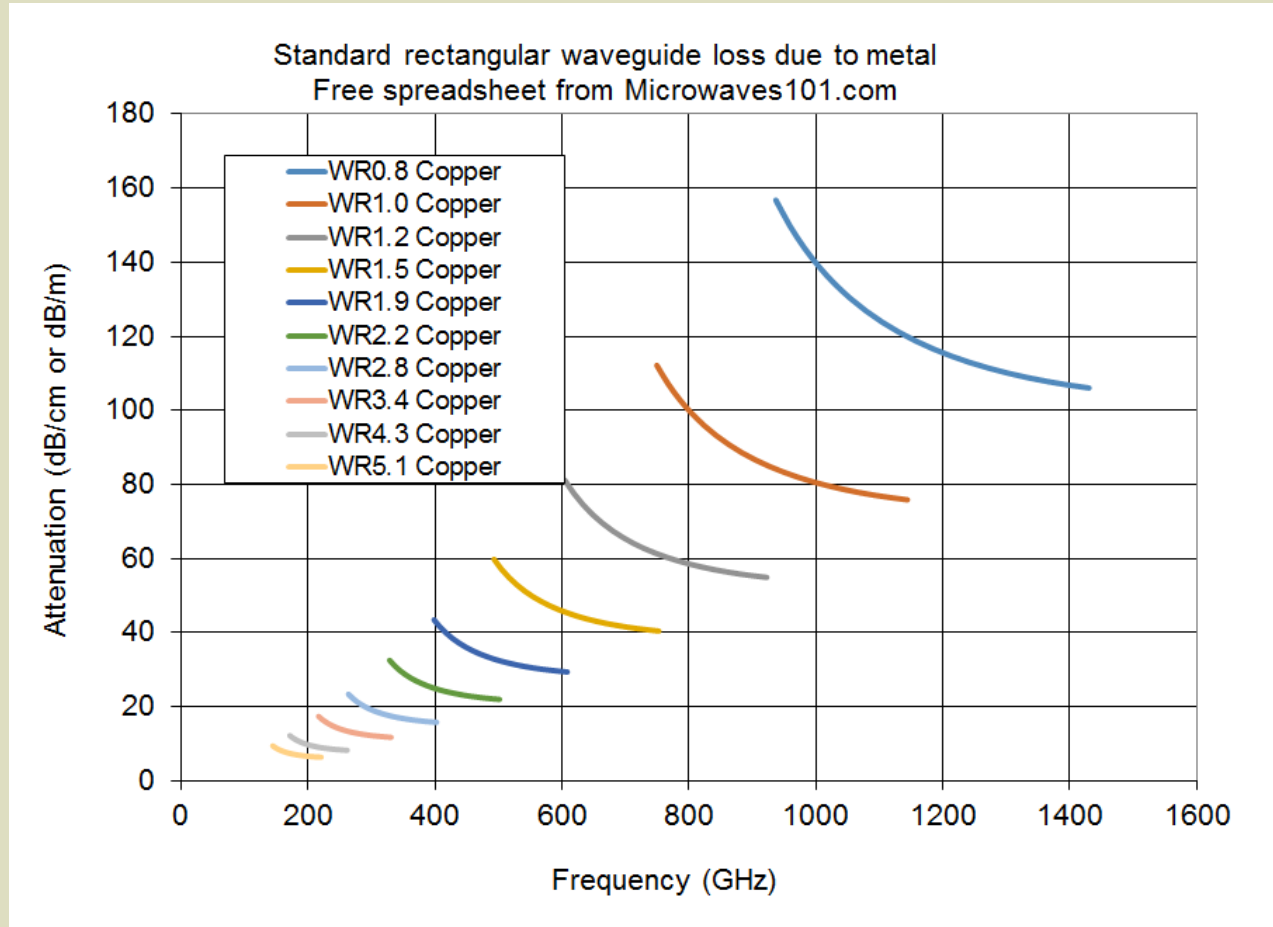
ps

Loss examples



Loss examples for typical semi-rigid coax, waveguide and microstrip lines

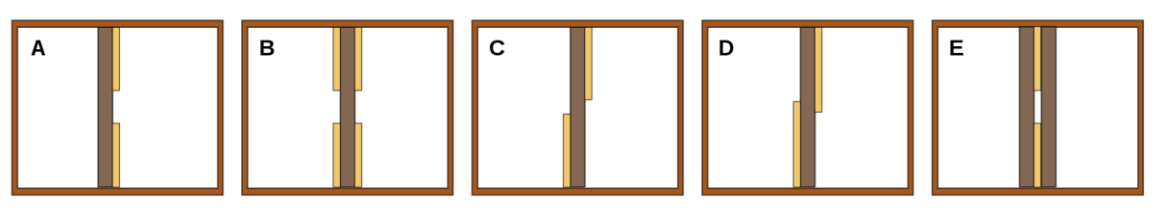
Waveguide Bands and Loss



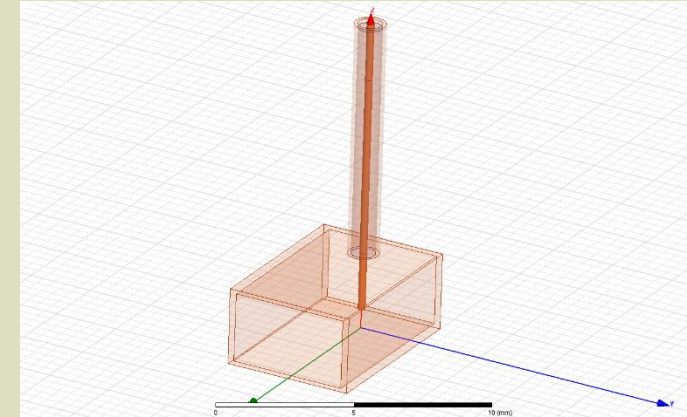
Source:
https://commons.wikimedia.org/wiki/File:Waveguide_x_EM_rect_TE31.gif

Source: <https://www.microwaves101.com/encyclopedias/waveguide-loss>

Waveguide Interface Examples



Fineline
(extends out from
waveguide onto PCB)



Waveguide post
(extends out from
waveguide into coax)

By Courtesy Spinningspark at Wikipedia, CC BY-SA 3.0,
<https://en.wikipedia.org/w/index.php?curid=53088299>

Atmospheric Loss

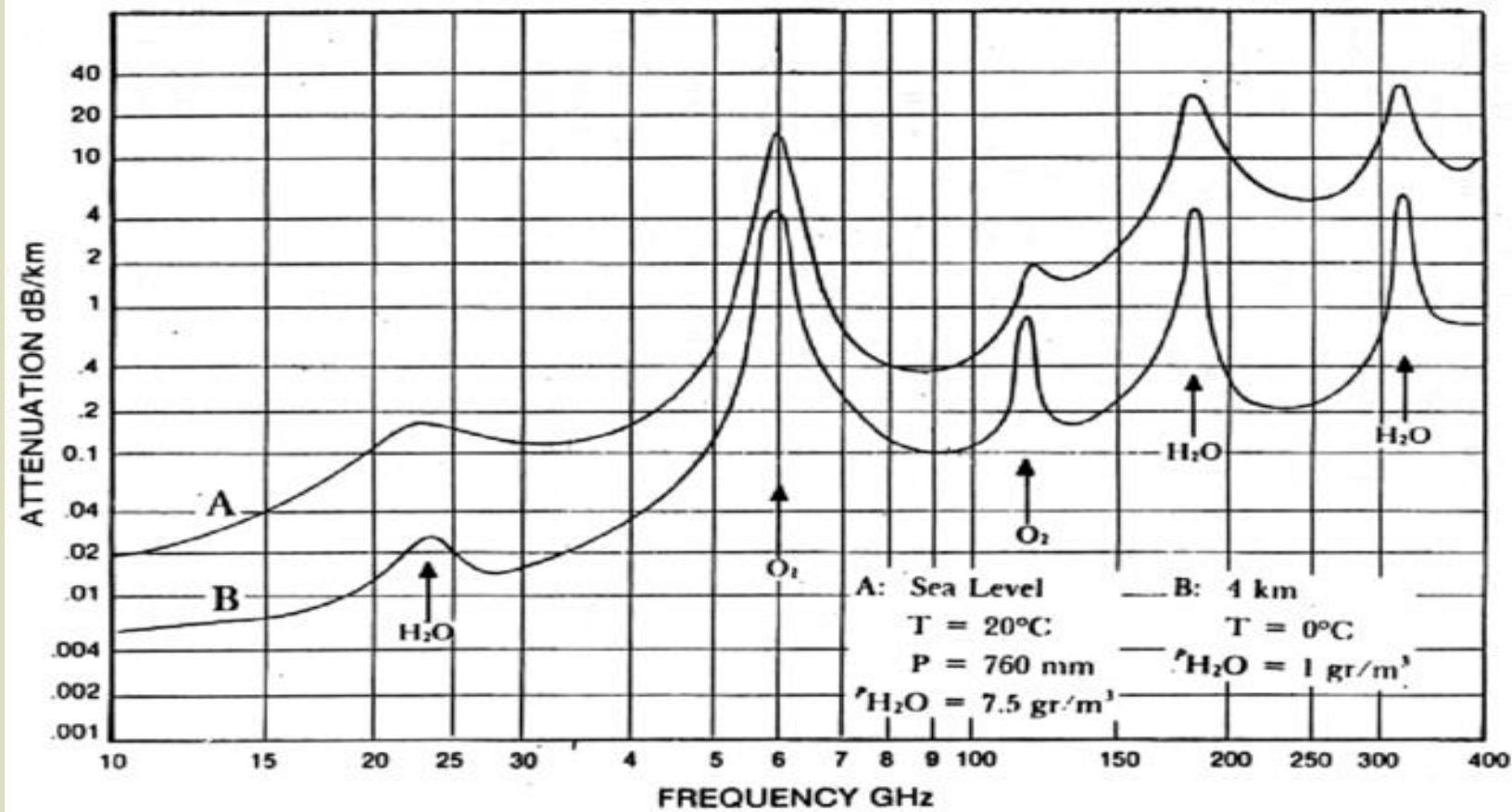


Figure 4: Average Atmospheric Absorption of Millimeter Waves.

Source: Wikimedia - File:Millimeter waves atmospheric loss.png

Wave propagation through air has vastly lower loss than in coax/PCB traces.

Frequency windows of higher absorption exists, however.

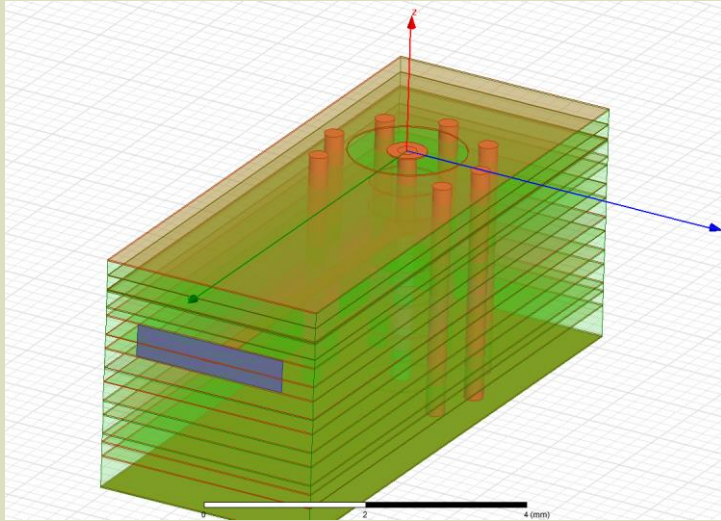
Some mm-wave Socket Design Considerations

- A good design for lower frequency sockets can be used as a point of departure:
 - Scaling (all 3 dimensions) is possible if pitch is also scaled, e.g. a very good 0.8 mm socket design will likely at least yield a reasonable 0.4 mm pitch design for higher frequency operation.
 - Materials that work well to 40 GHz will likely do so to higher frequencies.
 - Plating thicknesses need not be scaled.
 - The design must be verified since interface parasitics (e.g. L, C) will not necessarily scale as desired.

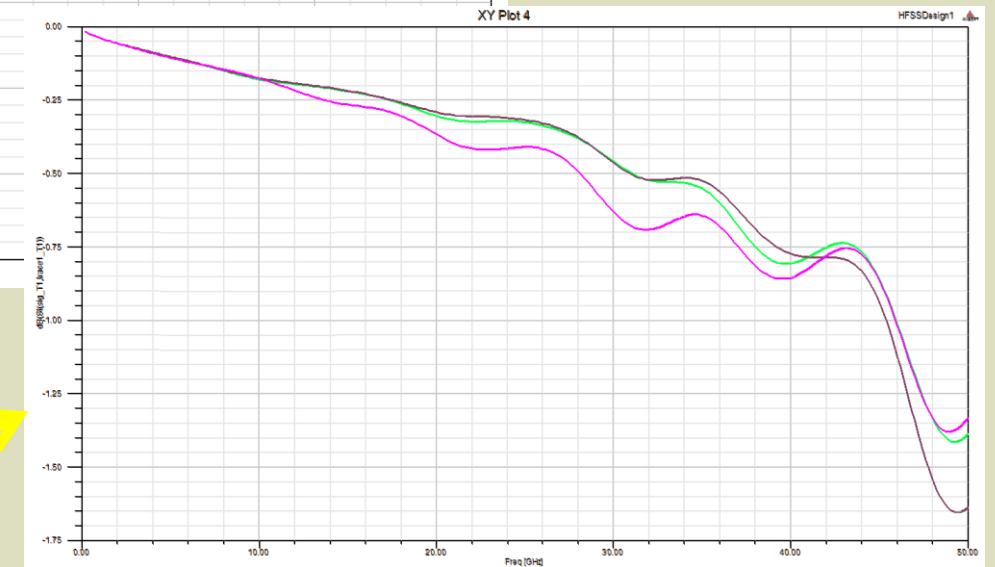
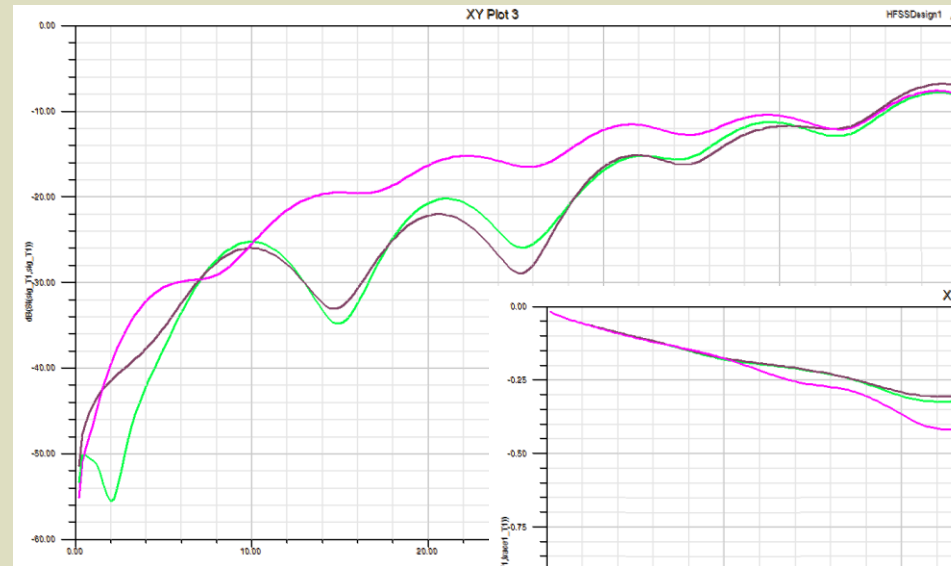
Some mm-wave Socket Design Considerations

- PAM – 4 operation requires good crosstalk and good return loss performance
 - Return loss will be best if socket is designed to be 100 Ohms differential characteristic impedance (50 Ohms if signals are single-ended)
 - This design will generally NOT be equivalent to an optimal single-ended 50 Ohms impedance case
 - It is risky to generalize design advice for minimal differential crosstalk since unexpected results can and will be encountered. Designs must be verified via simulation in each specific case.
 - The PCB design (via and pad/antipad diameters as well as locations **must be** optimized for the intended socket.

PCB Interface – Insertion and Return loss



*Example: Coaxial feed structure
(3 different parameter choices shown)*

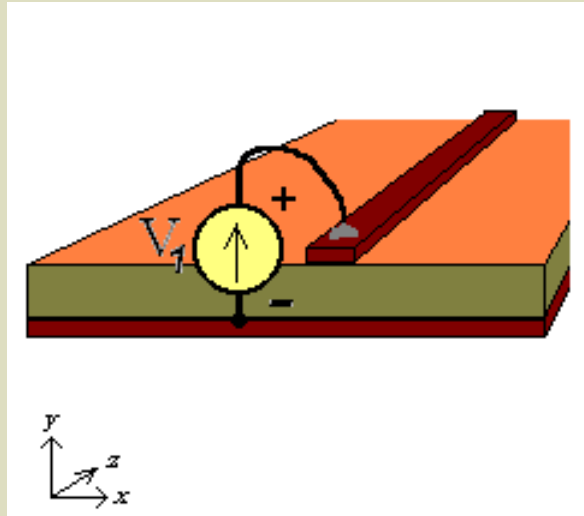


Return loss S11 and insertion loss S21 depend on the internal construction of the PCB.

A good socket design can be “ruined” by a poor PCB design.

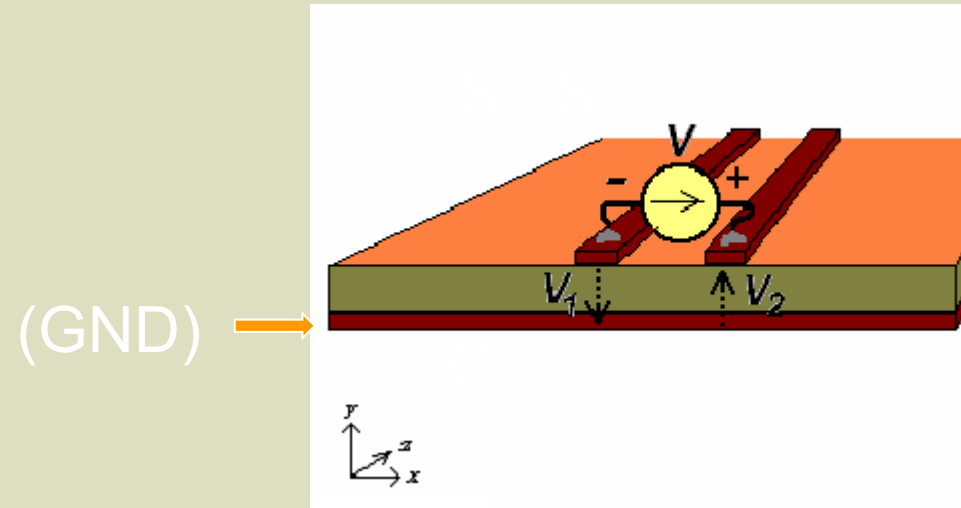
Single Ended vs. Differential Signaling

SE



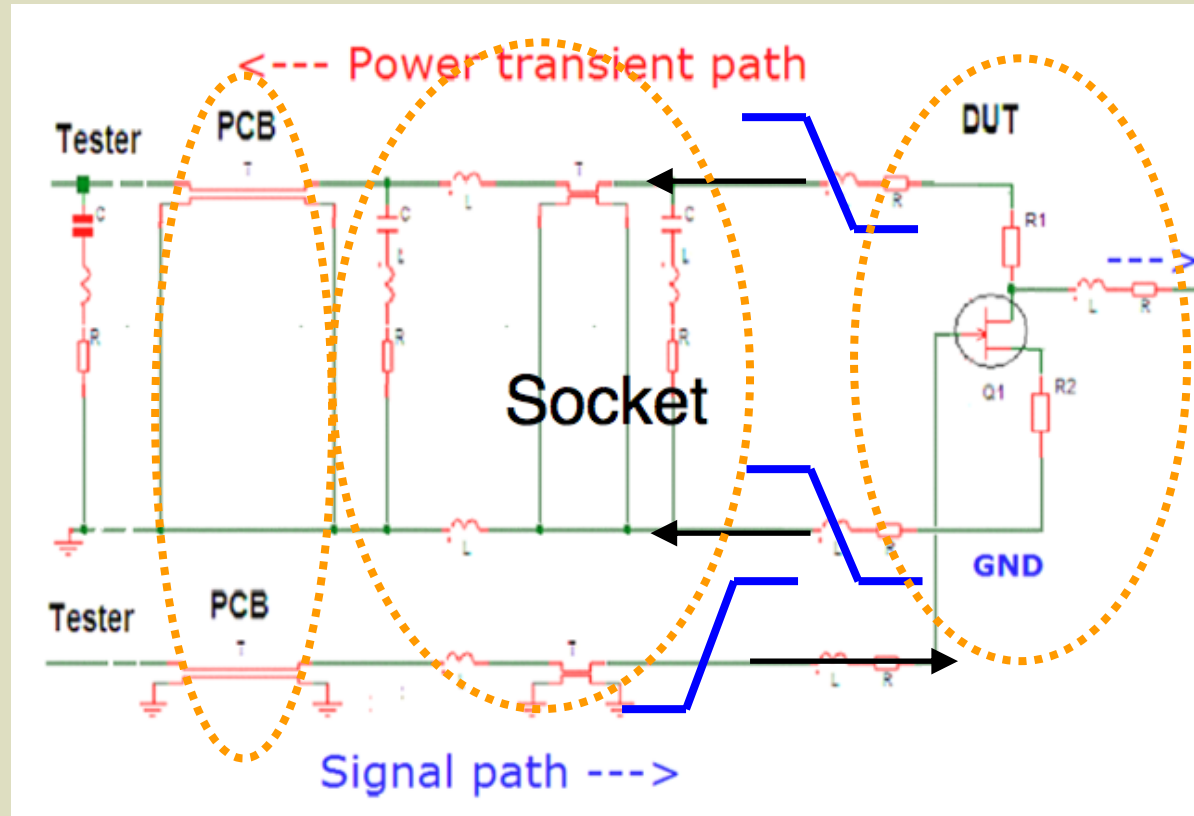
A voltage is established between a signal line and ground.

Differential



A voltage is established between two signal lines. The ground (underside of the circuit board) serves merely as a reference. Thus differential signaling is much less affected by what surrounds the signal path. But...

Signal and Power Paths



At mm-wave frequencies it is imperative to consider not only the signal flow but also ground return and power delivery paths

Socket SI Parameters

- Impedance Z_o
- Delay t_d
- Capacitance C
- Inductance L
- Mutual elements C_m, L_m

Example of relevant socket parameters

Relevant Socket Parameters

- Ground locations
- Pitch
- Contact length
- Contact lateral dimensions
- Housing construction (metal vs. dielectric)
- Housing material, e.g. dielectric constant

Only major parameters that affect SI are listed

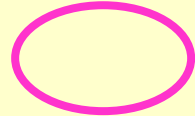
Trend tables: Electrical vs. mechanical characteristics

	Mechanical parameters			Properties	
Electrical characteristics	diameter	length	pitch	conductivity	dielectric constant
L	vvv	^^	^^	--	--
C	^^^	^^	vv	--	^^
Lm	vv	^^	vv	--	--
Cm	vv	^^	vv	--	^^
Cres	vv	^^	--	vv	--
Zo	vvv	--	^^	--	vv
td	--	^^	--	--	^

Legend:

An increase of the table parameter results in the following change ---->


^^^	strong increase
^^	increase
--	neutral
vv	decrease
vvv	strong decrease
v^	either way

What is most important for mm-wave socket: 

Trend tables: Physical characteristics vs. SI/PI performance

	Mechanical parameters			Properties	
Performance parameters	diameter	length	pitch	conductivity	dielectric constant
S11	v [^]	^	v [^]	--	v [^]
S21	v [^]	^	v [^]	--	v [^]
S41	v [^]	^	v [^]	--	v [^]
didt	v	^	^	--	--
Zpds	v	^	^	--	--
Rdc	v	^	--	v	--
Qdot	v	^	v	v	--

Tables are based on basic mathematical relations and frequently observed responses- they are only meant to serve as a guide.

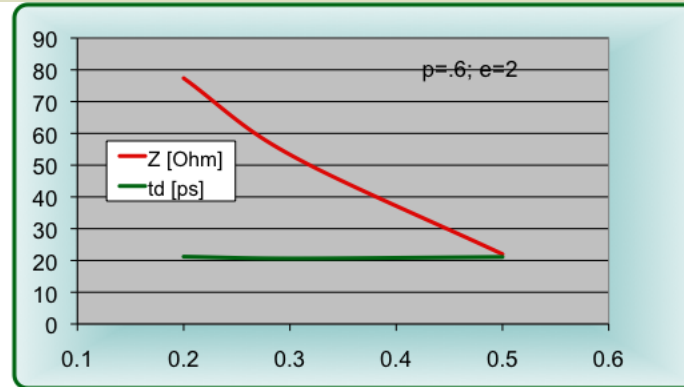
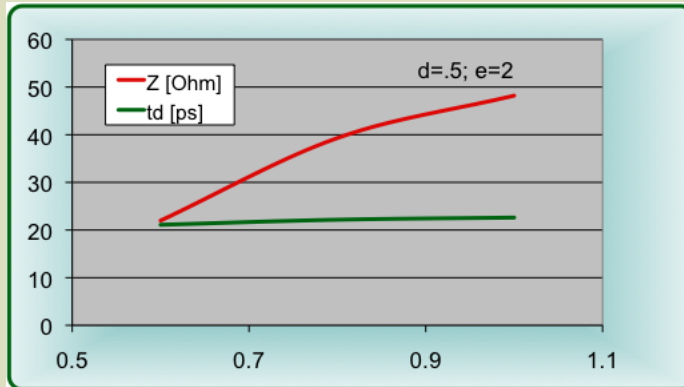
What is most important for mm-wave socket: 

Dimensions vs. SI/PI parameters

Pitch

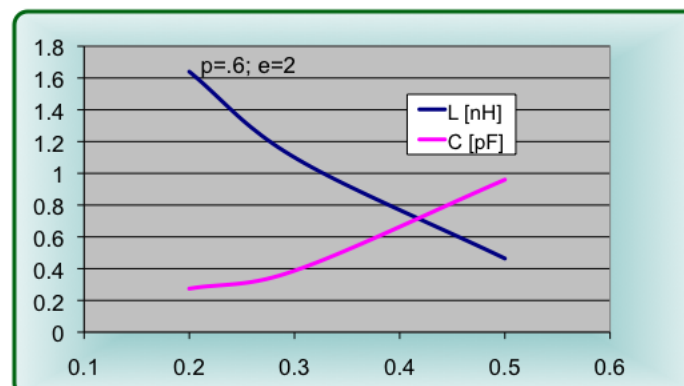
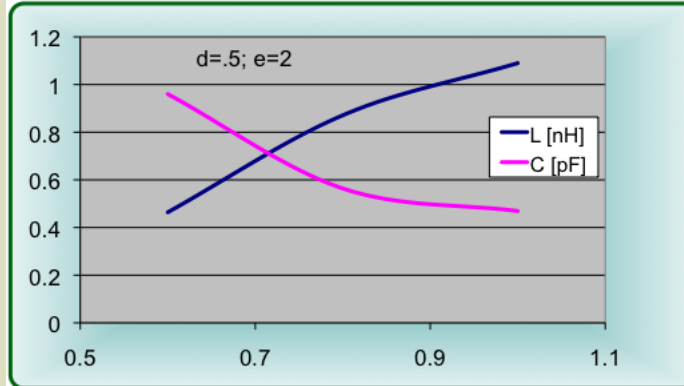
Diameter

[Ω]



[mm]

[nH/pf]



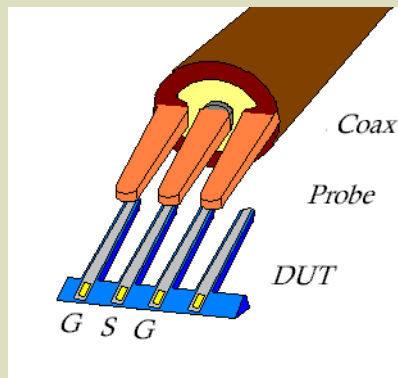
[mm]

Mutual inductance and capacitance will change significantly, too

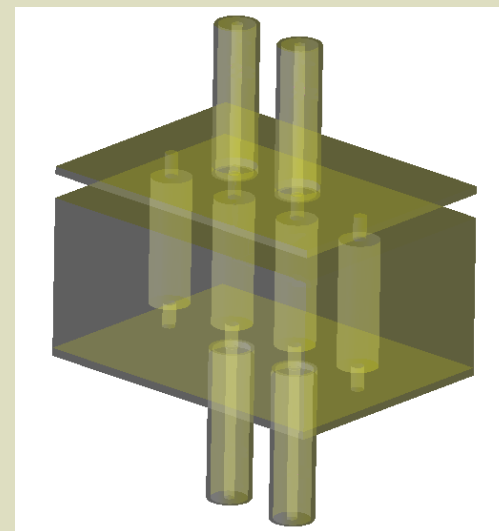
Test Methodology for EHF Socket Measurements



VNA



Probes



G-S-S-G test arrangement with coax feeds



DUT

Test Methodology for EHF Socket Measurements



De-embedding (Fixture removal):

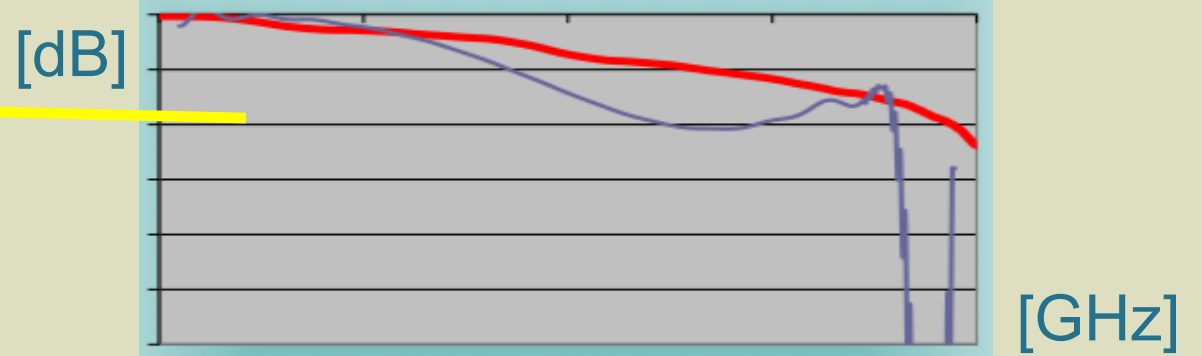
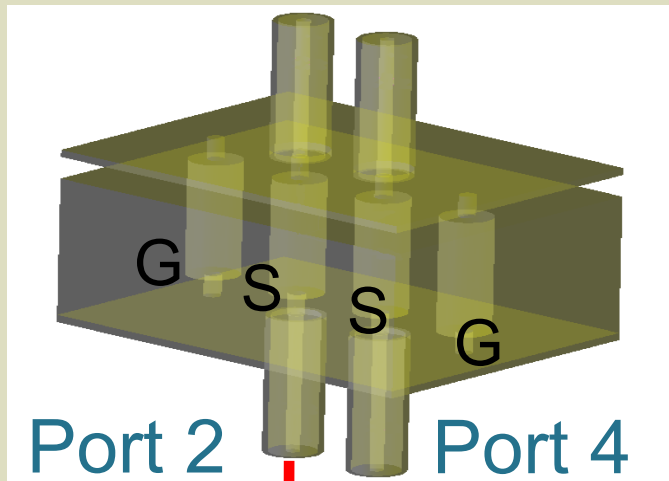
A process of calibration and data processing that moves the so-called reference planes right up to the device to be tested. This effectively removes all contributions from coax cables, probes and fixturing. It leaves only the data that are associated with the device under test (DUT) itself.

Socket Test:

... performance parameters vs. electrical characteristics ...

- Insertion loss (S21)
- Return loss (S11)
- Crosstalk (S31, S41)

Port 1 ↓ ↑ Port 3



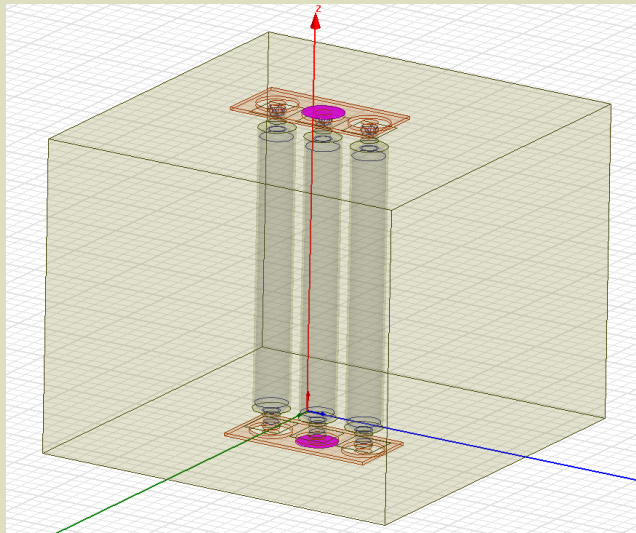
Simulated performance (blue) is not always better than measured (red)

- Impedance $Z_0 \sim = \sqrt{L / C}$
- Delay t_d
- Capacitance C
- Inductance L
- Mutual elements C_m, L_m

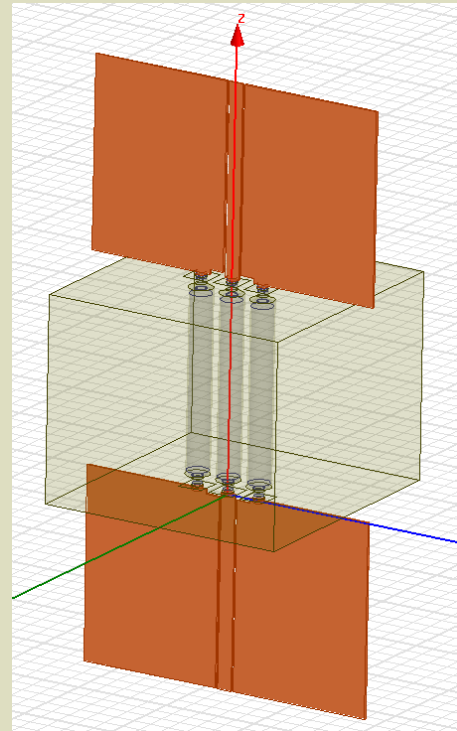
Typical Test Equipment for EHF Socket Measurements

- *Network analyzers*
 - *Scalar network analyzer*
(generate only amplitude response e.g. insertion loss)
 - *Vector network analyzer*
(generate full datasets with phase information that can be used in system performance simulations)
- *(Time domain reflectometers)*
- *Custom built analyzers*

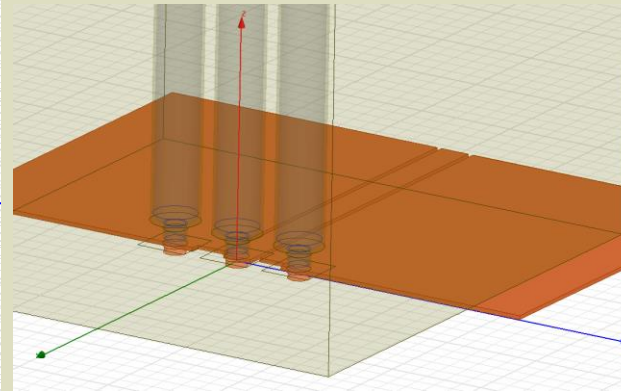
Socket Test Interfaces



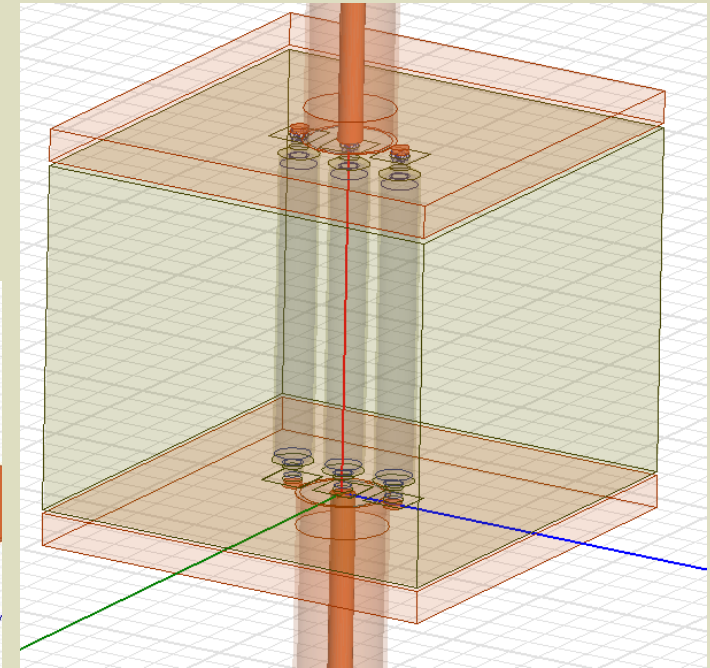
GSG with direct feed



- CPW probes

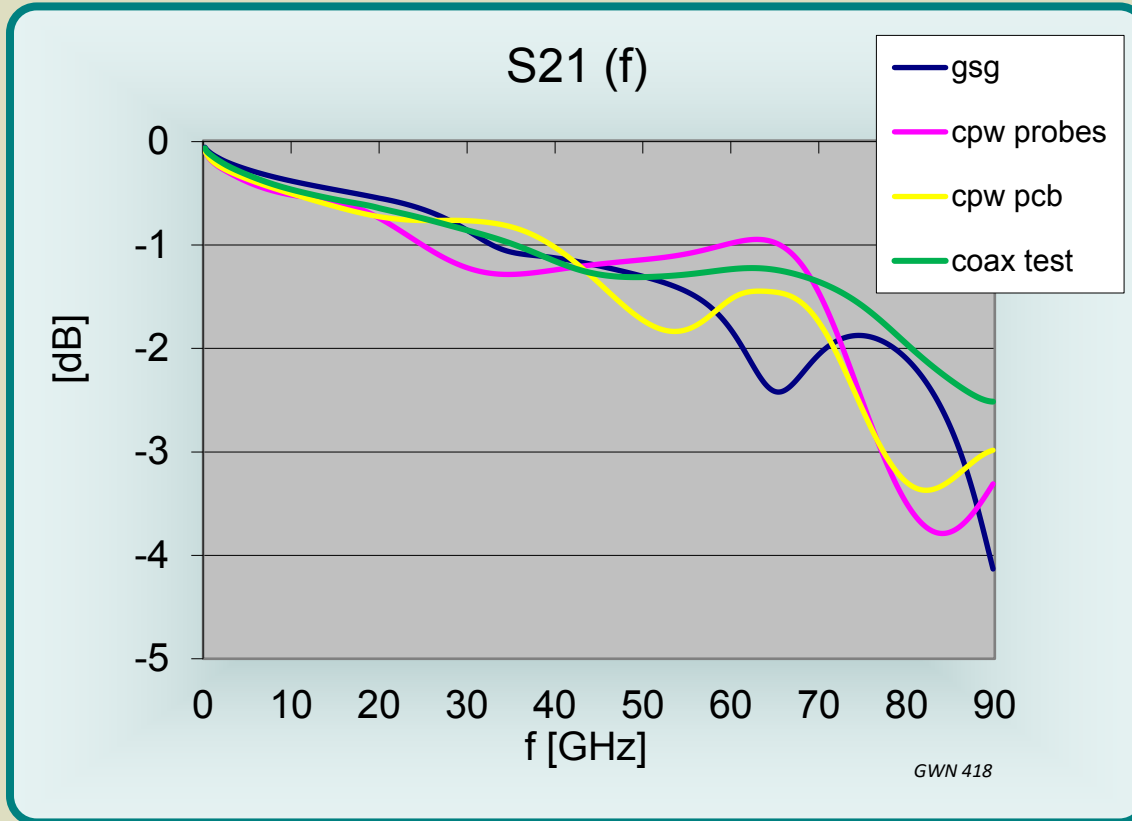


- CPW on PCB



- Test configuration

Socket Test Results – Insertion loss

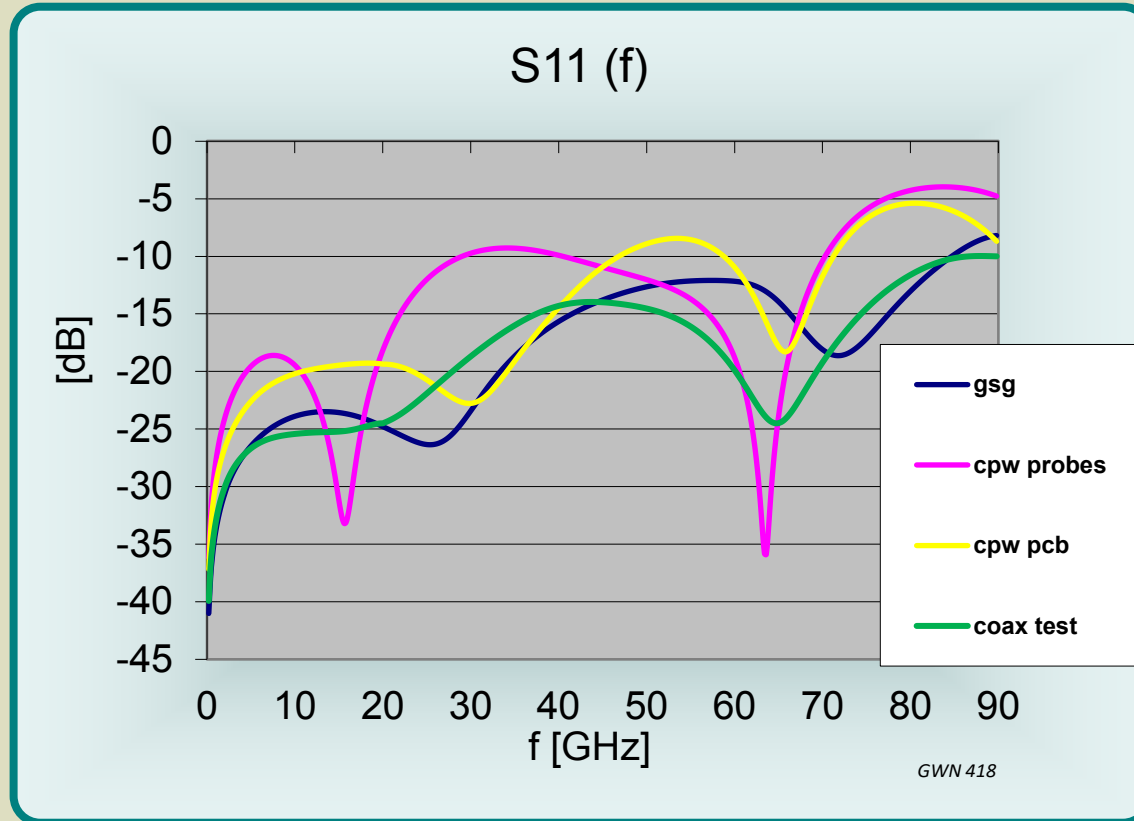


Insertion loss begins to depend on feed structure for $f > 20$ GHz. A coax test configuration in this case provides consistent good performance beyond 90 GHz.

Insertion loss for different feed structures

(example socket here has 0.35 mm pitch)

Socket Test Results – Return loss



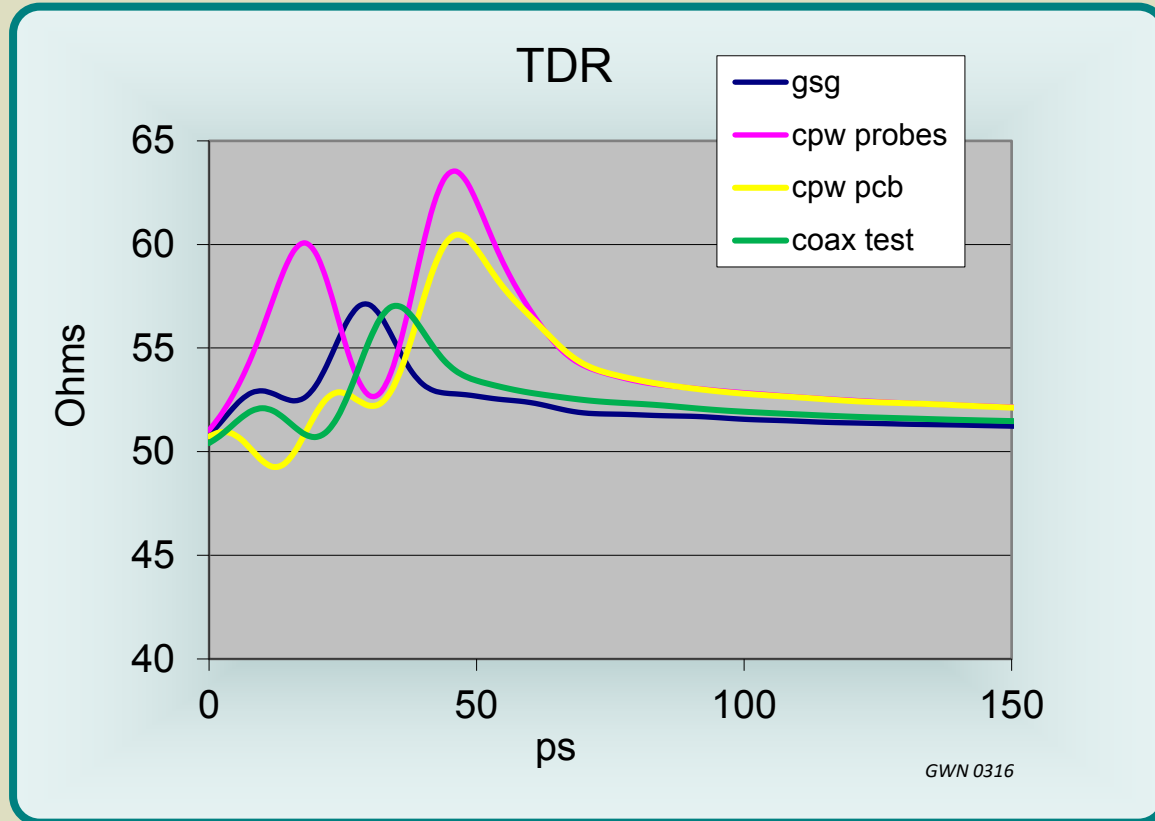
Return loss depends on feed structure.

Coax test configuration in this case provides comparable performance to direct GSG feed.

Insertion loss for different feed structures

(example has 0.35 mm pitch)

Socket Test Results – Impedance

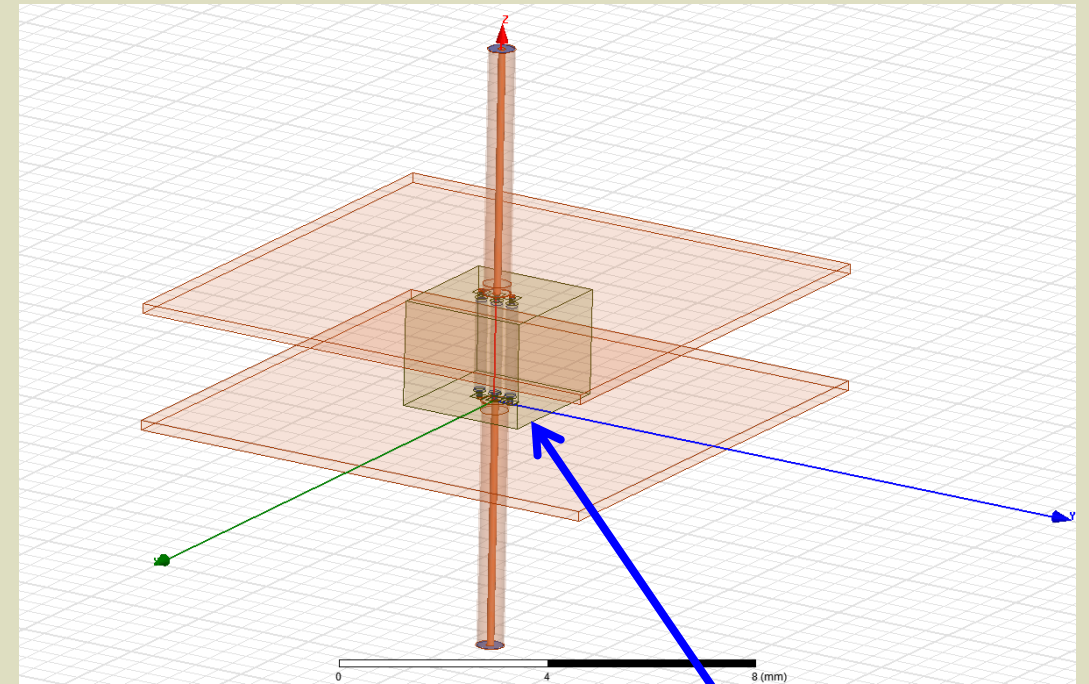
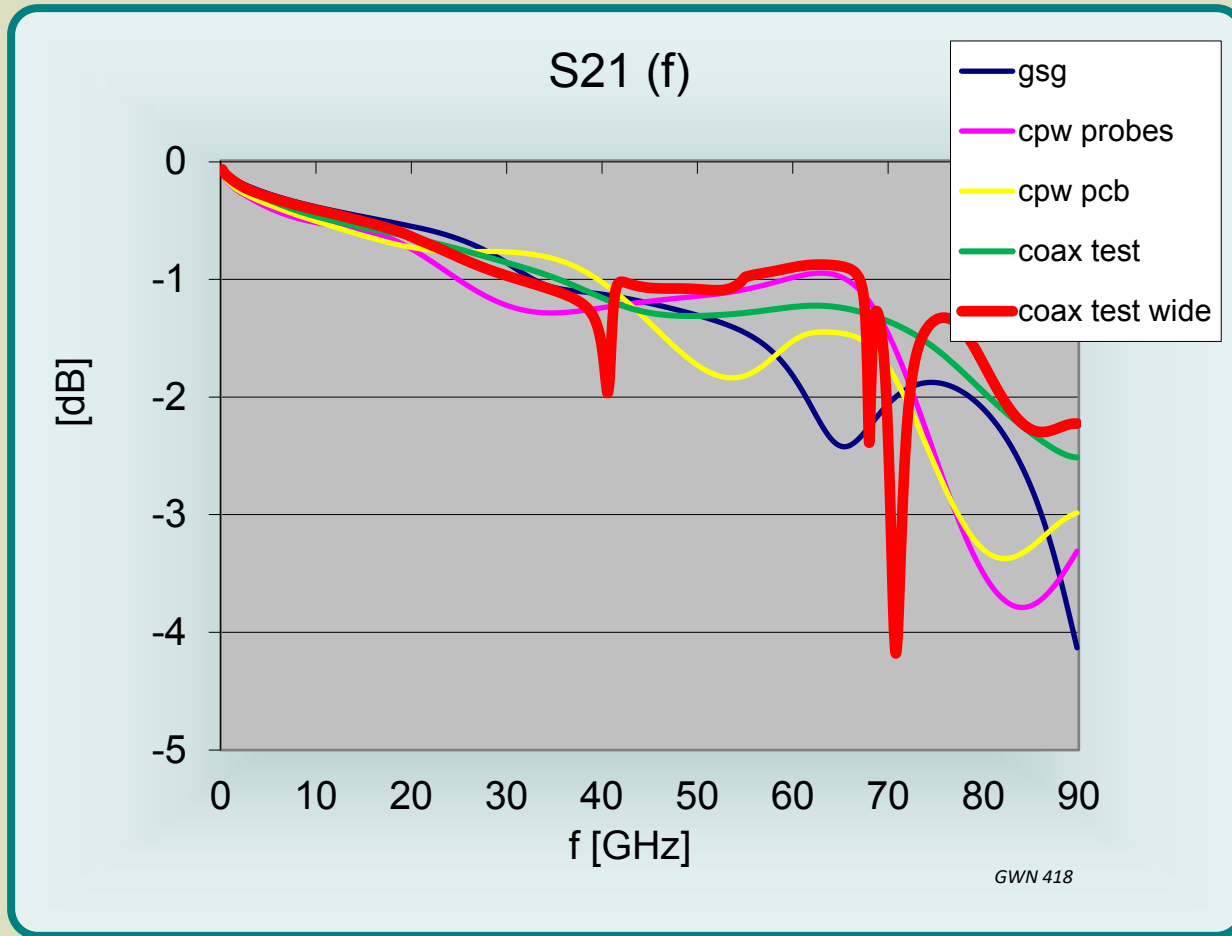


Observed impedance discontinuities exist depending on feed structure.

Coax test configuration in this case provides comparable performance to direct GSG feed.

Insertion loss for different feed structures
(example has 0.35 mm pitch)

Socket Test Results – Insertion loss



Feed structure with extended bases shows resonances (modes in dielectric)

Conclusion

- Resonance and interface effects become a major issue at mm-wave frequencies.
- A PCB design optimization must accompany socket design/application.
- Use of sockets in mm-wave applications requires a good grasp of what may happen when wavelength approaches contact size and pitch dimensions.